

## ISL8274M

30A/30A Dual-Channel Digital PMBus Step-Down Power Module

FN8931  
Rev.1.00  
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The [ISL8274M](#) is a complete PMBus enabled DC/DC, dual-channel, step-down advance power supply, capable of delivering up to 30A per channel and optimized for high power density applications.

Operating across an input voltage range of 4.5V to 14V, the ISL8274M offers adjustable output voltages down to 0.6V and achieves up to 95.5% conversion efficiencies. A unique ChargeMode™ control architecture provides a single clock cycle response to an output load step and can support switching frequencies up to 1.06MHz. The power module integrates all power and most passive components and requires only a few external components to operate. A set of optional external resistors allows the user to easily configure the device for standard operation. For advanced configurations, a standard PMBus interface addresses tasks such as sequencing and fault management, as well as real-time full telemetry and point-of-load monitoring. Additionally, the nonvolatile memory can store the desired custom configuration and settings.

A fully customizable voltage, current, and temperature protection scheme ensures safe operation for the ISL8274M under abnormal operating conditions. The device is also supported by the PowerNavigator™ software, a full digital power train development environment.

The ISL8274M is available in a low profile, compact 18mmx23mmx7.5mm fully encapsulated, thermally enhanced HDA package.

### Applications

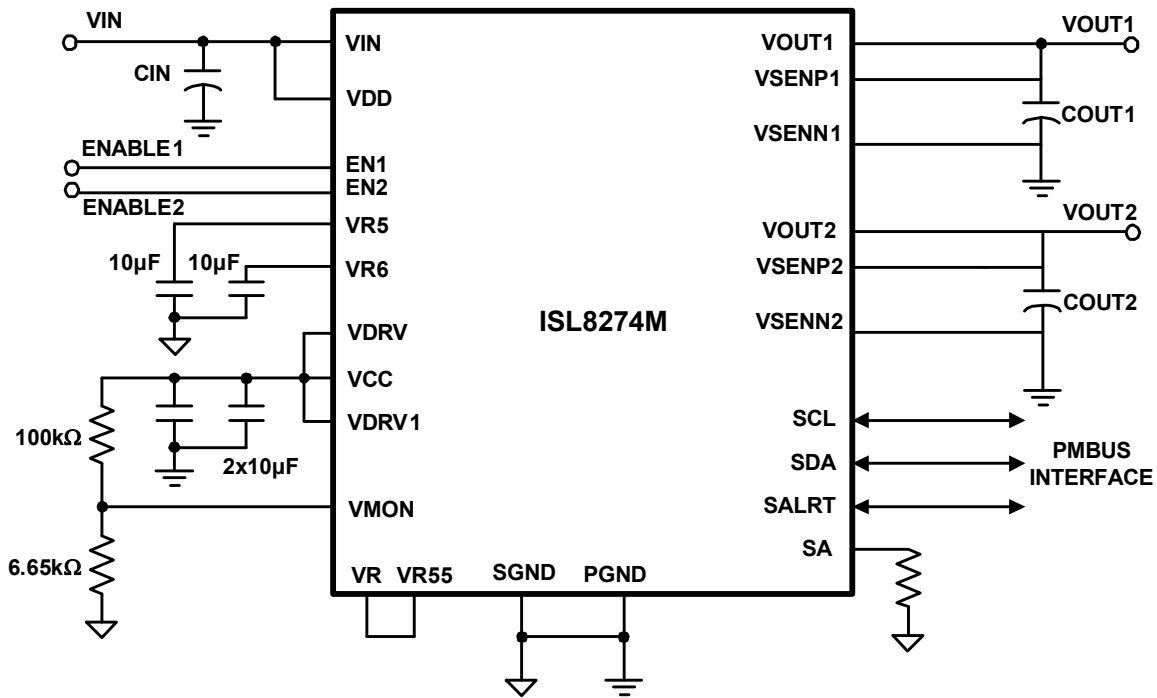
- Server, telecom, storage, and datacom
- Industrial/ATE and networking equipment
- General purpose power for ASIC, FPGA, DSP, and memory

### Features

- Complete digital power supply
- 30A/30A dual-channel output current
  - 4.5V to 14V single rail input voltage
  - Up to 95.5% efficiency
- Programmable output voltage
  - 0.6V to 5V output voltage settings
  - ±1.2% accuracy over line/load/temperature
- ChargeMode control loop architecture
  - 296kHz to 1.06MHz fixed switching frequency operations
  - No compensation required
  - Fast single clock cycle transient response
- PMBus interface and/or pin-strap mode
  - Fully programmable through PMBus
  - Pin-strap mode for standard settings
  - Real-time telemetry for  $V_{IN}$ ,  $V_{OUT}$ ,  $I_{OUT}$ , temperature, duty cycle, and  $f_{SW}$
- Advanced soft-start/stop, sequencing, and tracking
- Internal nonvolatile memory
- Complete over/undervoltage, current, and temperature protections with fault logging
- [PowerNavigator](#) supported
- Thermally enhanced 18mmx23mmx7.5mm HDA package

### Related Literature

- For a full list of related documents, visit our website
  - [ISL8274M](#) product page



Note: This figure represents a typical implementation of the ISL8274M. For PMBus operation, it is recommended to tie the enable pin (EN) to SGND.

Figure 1. Application Circuit

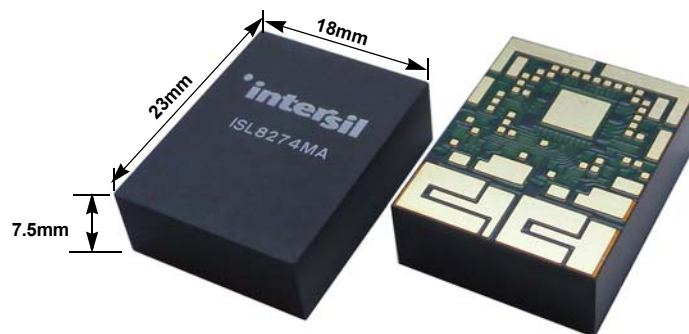


Figure 2. Small Package for High Power Density

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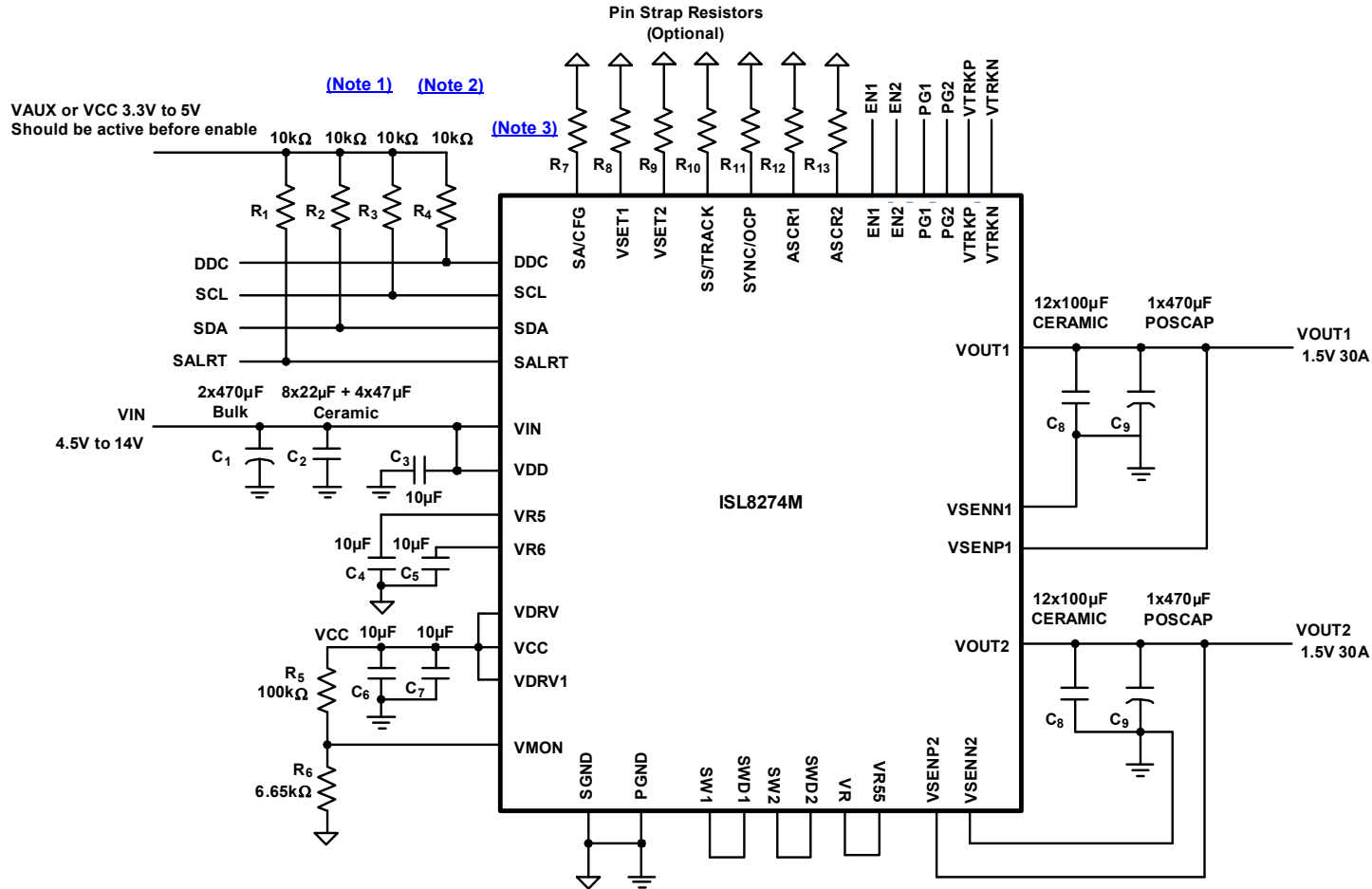
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# 1. Overview

## 1.1 Typical Application Circuits



Notes:

1. R<sub>2</sub> and R<sub>3</sub> are not required if the PMBus host already has I<sup>2</sup>C pull-up resistors.
2. Only one R<sub>4</sub> per DDC bus is required when multiple modules share the same DDC bus.
3. R<sub>7</sub> through R<sub>13</sub> can be selected according to the tables for the pin-strap resistor setting in this document.  
If the PMBus configuration is chosen to overwrite the pin-strap configuration, R<sub>8</sub> through R<sub>13</sub> can be non-populated.
4. V<sub>25</sub>, VR, and VR<sub>55</sub> do not need external capacitors. V<sub>25</sub> can be no connection.

Figure 3. ISL8274M Digital PMBus Module Dual 30A/30A Application with Pinstrap Settings

## 1.2 ISL8274M Internal Block Diagram

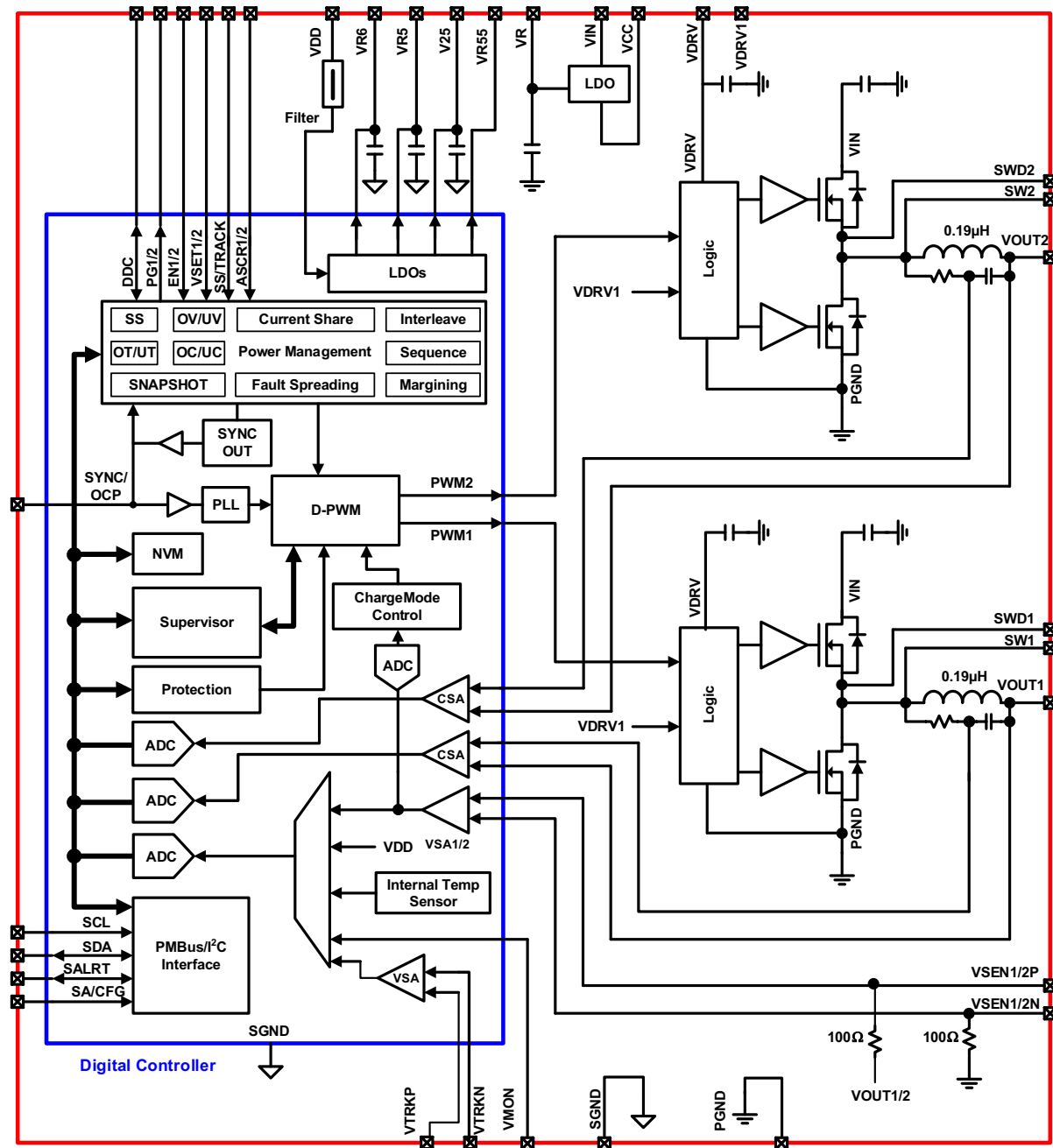


Figure 4. Internal Block Diagram

### 1.3 Ordering Information

| Part Number<br>(Notes 5, 6, 7) | Part Marking     | Temp Range<br>(°C) | Package<br>(RoHS Compliant) | Pkg.<br>Dwg. # |
|--------------------------------|------------------|--------------------|-----------------------------|----------------|
| ISL8274MAIRZ                   | ISL8274MA        | -40 to +85         | 58 LD 18x23 HDA Module      | Y58.18x23      |
| ISL8274MEVAL1Z                 | Evaluation Board |                    |                             |                |

Notes:

5. Add "-T" suffix for 100 unit tape and reel option. Refer to [TB347](#) for details on reel specifications.
6. These Pb-free plastic packaged products are RoHS compliant by EU exemption 7C-I and 7A. They employ special Pb-free material sets; molding compounds/die attach materials and NiPdAu plate-e4 termination finish, which is compatible with both SnPb and Pb-free soldering operations. Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
7. For Moisture Sensitivity Level (MSL), see the product information page for the [ISL8274M](#). For more information on MSL, see [TB363](#).

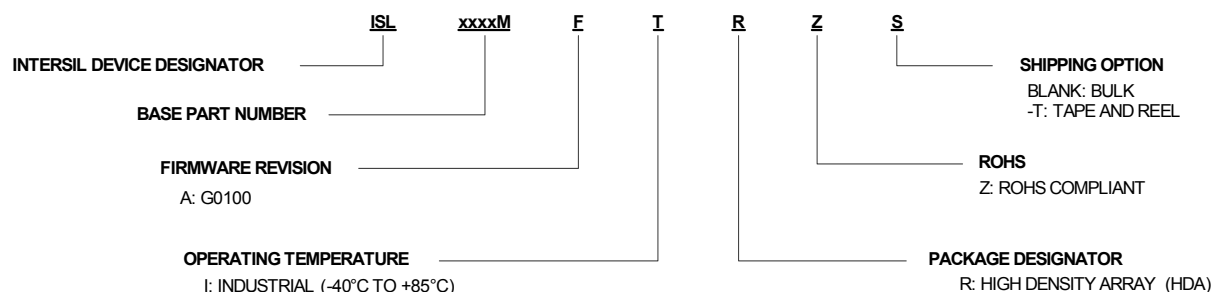
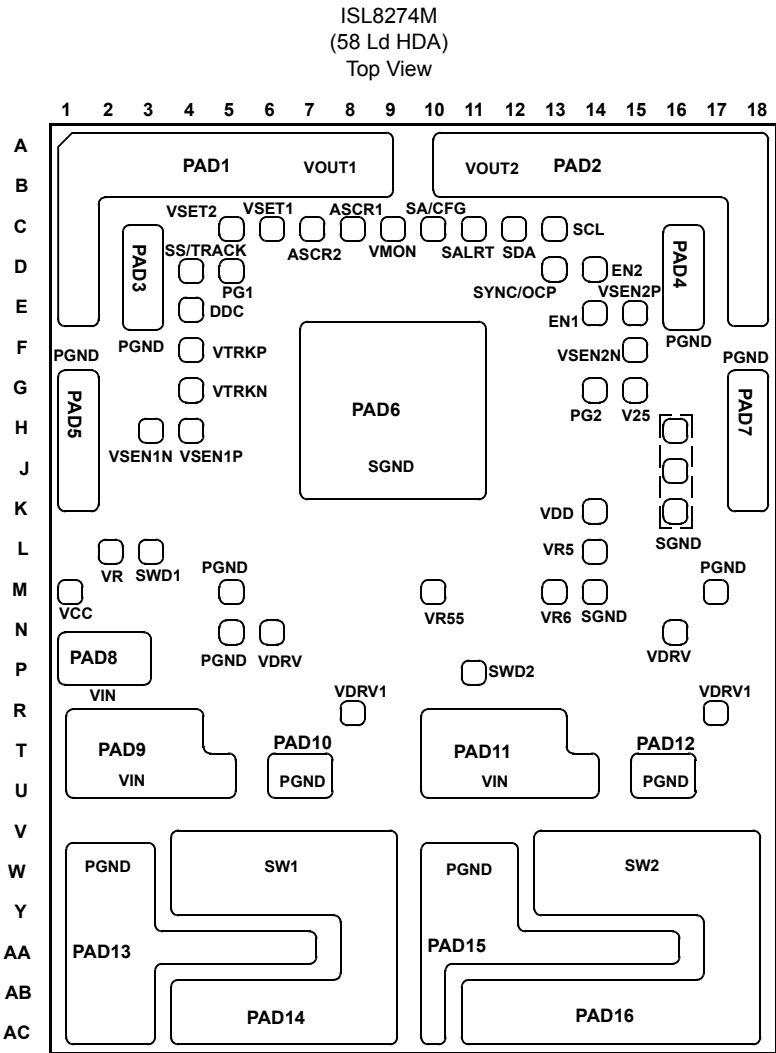


Table 1. Key Differences Between Family of Parts

| Part     | Description                                     | V <sub>IN</sub> Range (V) | V <sub>OUT</sub> Range (V) | I <sub>OUT</sub> (A) |
|----------|-------------------------------------------------|---------------------------|----------------------------|----------------------|
| ISL8274M | Digital DC/DC PMBus Dual Channel 30A/30A Module | 4.5 - 14                  | 0.6 - 5.0                  | 30/30                |
| ISL8272M | Digital DC/DC PMBus Single Channel 50A Module   | 4.5 - 14                  | 0.6 - 5.0                  | 50                   |
| ISL8273M | Digital DC/DC PMBus Single Channel 80A Module   | 4.5 - 14                  | 0.6 - 2.5                  | 80                   |
| ZL9024M  | Digital DC/DC PMBus Single Channel 33A Module   | 2.75-4                    | 0.6 - 1.5                  | 33                   |

1.4 Pin Configuration





## 1.5 Pin Descriptions

| Pin Number                                         | Pin Name | Type | Description                                                                                                                                                                                                                                                                                            |
|----------------------------------------------------|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PAD1                                               | VOUT1    | PWR  | Power supply output voltage. Channel 1 provides an output voltage from 0.6V to 5V. Refer to the <a href="#">"Functional Description" on page 21</a> to set the maximum output current from these pads.                                                                                                 |
| PAD2                                               | VOUT2    | PWR  | Power supply output voltage. Channel 2 provides an output voltage from 0.6V to 5V. Refer to the <a href="#">"Functional Description" on page 21</a> to set the maximum output current from these pads.                                                                                                 |
| PAD3, PAD4, PAD5, PAD7, PAD10, PAD12, PAD13, PAD15 | PGND     | PWR  | Power ground. Refer to the <a href="#">"Layout Guide" on page 33</a> for the PGND pad connections and I/O capacitor placement.                                                                                                                                                                         |
| PAD6                                               | SGND     | PWR  | Signal ground. Refer to <a href="#">"Layout Guide" on page 33</a> for the SGND pad connections.                                                                                                                                                                                                        |
| PAD8, PAD9, PAD11                                  | VIN      | PWR  | Input power supply voltage to power the module. Input voltage ranges from 4.5V to 14V.                                                                                                                                                                                                                 |
| PAD14                                              | SW1      | PWR  | Switching node pads for Channel 1. The SW1 pad is used to dissipate the heat and provide the good thermal performance. Refer to <a href="#">"Layout Guide" on page 33</a> for the SW1 pad connections.                                                                                                 |
| PAD16                                              | SW2      | PWR  | Switching node pads for Channel 2. The SW2 pad is used to dissipate the heat and provide the good thermal performance. Refer to <a href="#">"Layout Guide" on page 33</a> for the SW2 pad connections.                                                                                                 |
| C5                                                 | VSET2    | I    | Output voltage selection pin for Channel 2. Used to set VOUT2 set point and VOUT2 max.                                                                                                                                                                                                                 |
| C6                                                 | VSET1    | I    | Output voltage selection pin for Channel 1. Used to set VOUT1 set point and VOUT1 max.                                                                                                                                                                                                                 |
| C7                                                 | ASCR2    | I    | ChargeMode control ASCR parameters selection pin for Channel 2. Used to set ASCR gain and residual values.                                                                                                                                                                                             |
| C8                                                 | ASCR1    | I    | ChargeMode control ASCR parameters selection pin for Channel 1. Used to set ASCR gain and residual values.                                                                                                                                                                                             |
| C9                                                 | VMON     | I    | Driver voltage monitoring. Use this pin to monitor VDRV through an external 16:1 resistor divider.                                                                                                                                                                                                     |
| C10                                                | SA/CFG   | I    | Serial address selection pin. Used to assign unique address for each individual device or to enable certain management features. This pin also sets the UVLO level.                                                                                                                                    |
| C11                                                | SALRT    | O    | Serial alert. Connect to external host if desired. SALRT is asserted low upon a warning or a fault event and deasserted when warning or fault is cleared. A pull-up resistor is required.                                                                                                              |
| C12                                                | SDA      | I/O  | Serial data. Connect to external host and/or to other Digital-DC™ devices. A pull-up resistor is required.                                                                                                                                                                                             |
| C13                                                | SCL      | I/O  | Serial clock. Connect to external host and/or to other Digital-DC devices. A pull-up resistor is required.                                                                                                                                                                                             |
| D4                                                 | SS/TRACK | I    | Soft-start/stop selection pin. Used to set turn on/off delay and ramp time as well as tracking configuration.                                                                                                                                                                                          |
| D5                                                 | PG1      | O    | Power-good output for Channel 1. Power-good output can be an open drain that requires a pull-up resistor or push-pull output that can drive a logic input.                                                                                                                                             |
| D13                                                | SYNC/OCP | I/O  | Clock synchronization input and OCP setting pin. Used to set the frequency of the internal switch clock, to sync to an external clock or to output internal clock. If external synchronization is used, the external clock must be active before enable. Different OCP level can be set with this pin. |
| D14                                                | EN2      | I    | Enable pin for Channel 2. Logic high to enable the module output.                                                                                                                                                                                                                                      |
| E14                                                | EN1      | I    | Enable pin for Channel 1. Logic high to enable the module output.                                                                                                                                                                                                                                      |
| E4                                                 | DDC      | I/O  | A Digital-DC bus. This dedicated bus provides the communication between devices for features such as sequencing, fault spreading and current sharing. The DDC pin on all Digital-DC devices should be connected together. A pull-up resistor is required.                                              |
| E15                                                | VSEN2P   | I    | Differential output voltage sense feedback for Channel 2. Connect to positive output regulation point.                                                                                                                                                                                                 |
| F4                                                 | VTRKP    | I    | Tracking sense positive input. Used to track an external voltage source.                                                                                                                                                                                                                               |
| F15                                                | VSEN2N   | I    | Differential output voltage sense feedback for Channel 2. Connect to negative output regulation point.                                                                                                                                                                                                 |

| Pin Number         | Pin Name | Type | Description                                                                                                                                                                                                                                                                                                                          |
|--------------------|----------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| G4                 | VTCKN    | I    | Tracking sense negative input (return).                                                                                                                                                                                                                                                                                              |
| G14                | PG2      | O    | Power-good output for Channel 2. Power-good output can be an open drain that requires a pull-up resistor or push-pull output that can drive a logic input.                                                                                                                                                                           |
| G15                | V25      | PWR  | Internal 2.5V reference used to power internal circuitry. No external capacitor required for this pin. Not recommended to power external circuits.                                                                                                                                                                                   |
| H3                 | VSEN1N   | I    | Differential output voltage sense feedback for Channel 1. Connect to a negative output regulation point.                                                                                                                                                                                                                             |
| H4                 | VSEN1P   | I    | Differential output voltage sense feedback for Channel 1. Connect to a positive output regulation point.                                                                                                                                                                                                                             |
| H16, J16, K16, M14 | SGND     | PWR  | Signal grounds. Use multiple vias to connect the SGND pins to the internal SGND layer.                                                                                                                                                                                                                                               |
| K14                | VDD      | PWR  | Input supply voltage for controller. Connect VDD pad to VIN supply.                                                                                                                                                                                                                                                                  |
| L2                 | VR       | PWR  | Internal LDO bias pin. Tie VR to VR55 directly with a short loop trace. Not recommended to power external circuits.                                                                                                                                                                                                                  |
| L3                 | SWD1     | PWR  | Switching node driving pins for Channel 1. Directly connect to the SW1 pad with short loop wires.                                                                                                                                                                                                                                    |
| P11                | SWD2     | PWR  | Switching node driving pins for Channel 2. Directly connect to the SW2 pad with short loop wires.                                                                                                                                                                                                                                    |
| L14                | VR5      | PWR  | Internal 5V reference used to power internal circuitry. Place a 10 $\mu$ F decoupling capacitor for this pin. Maximum external loading current is 5mA.                                                                                                                                                                               |
| M1                 | VCC      | PWR  | Internal LDO output. Connect VCC to VDRV for internal LDO driving.                                                                                                                                                                                                                                                                   |
| M5, M17, N5        | PGND     | PWR  | Power grounds. Using multiple vias to connect the PGND pins to the internal PGND layer.                                                                                                                                                                                                                                              |
| M10                | VR55     | PWR  | Internal 5.5V bias voltage for internal LDO use only. Tie VR55 pin directly to the VR pin. Not recommended to power external circuit.                                                                                                                                                                                                |
| M13                | VR6      | PWR  | Internal 6V reference used to power internal circuitry. Place a 10 $\mu$ F decoupling capacitor for this pin. Not recommended to power external circuit.                                                                                                                                                                             |
| N6, N16            | VDRV     | PWR  | Power supply for internal FET drivers. Connect a 10 $\mu$ F bypass capacitor to each of these pins. These pins can be driven by the internal LDO through VCC pin or by the external power supply directly. Keep the driving voltage between 4.5V and 5.5V. For 5V input application, use external supply or connect this pin to VIN. |
| R8, R17            | VDRV1    | I    | Bias pin of the internal FET drivers. Always tie to VDRV.                                                                                                                                                                                                                                                                            |

Table 2. ISL8274M Design Guide Matrix and Output Voltage Response

| V <sub>OUT</sub> (V) | I <sub>OUT</sub> (A) | Avg OCP (A) | COUT_Bulk ( $\mu$ F) | COUT_Ceramic ( $\mu$ F) | ASCR Gain | ASCR Residual | Peak-to-Peak (mV) | Frequency (kHz) |
|----------------------|----------------------|-------------|----------------------|-------------------------|-----------|---------------|-------------------|-----------------|
| 5                    | 25                   | 30          | 1*470                | 6*100                   | 275       | 100           | 170               | 1067            |
| 5                    | 20                   | 25          | 1*470                | 6*100                   | 175       | 80            | 150               | 615             |
| 3.3                  | 25                   | 30          | 1*470                | 8*100                   | 300       | 90            | 150               | 800             |
| 3.3                  | 20                   | 25          | 1*470                | 8*100                   | 175       | 80            | 140               | 571             |
| 2.5                  | 30                   | 35          | 1*470                | 9*100                   | 600       | 100           | 110               | 1067            |
| 2.5                  | 25                   | 30          | 1*470                | 9*100                   | 350       | 100           | 120               | 615             |
| 2.5                  | 20                   | 25          | 1*470                | 9*100                   | 175       | 90            | 100               | 471             |
| 1.8                  | 30                   | 35          | 1*470                | 12*100                  | 600       | 100           | 90                | 889             |
| 1.8                  | 25                   | 30          | 1*470                | 12*100                  | 250       | 100           | 100               | 421             |
| 1.8                  | 20                   | 25          | 1*470                | 12*100                  | 200       | 100           | 100               | 364             |
| 1.5                  | 30                   | 35          | 1*470                | 12*100                  | 525       | 90            | 90                | 889             |
| 1.5                  | 25                   | 30          | 1*470                | 12*100                  | 250       | 100           | 90                | 421             |

**Table 2. ISL8274M Design Guide Matrix and Output Voltage Response (Continued)**

| V <sub>OUT</sub><br>(V) | I <sub>OUT</sub><br>(A) | Avg OCP<br>(A) | COUT_Bulk<br>(μF) | COUT_Ceramic<br>(μF) | ASCR<br>Gain | ASCR<br>Residual | Peak-to-Peak<br>(mV) | Frequency<br>(kHz) |
|-------------------------|-------------------------|----------------|-------------------|----------------------|--------------|------------------|----------------------|--------------------|
| 1.5                     | 20                      | 25             | 1*470             | 12*100               | 140          | 90               | 100                  | 320                |
| 1.2                     | 30                      | 35             | 1*470             | 12*100               | 600          | 110              | 70                   | 727                |
| 1.2                     | 25                      | 30             | 4*470             | 12*100               | 250          | 80               | 60                   | 296                |
| 1                       | 30                      | 35             | 1*470             | 12*100               | 450          | 110              | 80                   | 615                |
| 1                       | 25                      | 30             | 5*470             | 12*100               | 250          | 80               | 50                   | 296                |
| 0.6                     | 30                      | 35             | 7*470             | 12*100               | 300          | 90               | 50                   | 296                |

## Notes:

8. 2x470μF (EEE-1EA471P) and 12x22μF (GRM32ER71E226KE15L) are used for all conditions in the evaluation board.
9. 100μF (GRM31CD80J107ME39L) ceramic and 470μF (6TPF470MAH) are selected for output capacitor in the evaluation board.
10. Peak-to-peak V<sub>OUT</sub> deviation is measured under 50%-100% load transient while 12V input applied.
11. ASCR gain and residual was designed to achieve 50° phase margin over temperature. (Ambient temperature from -40°C to +85°C).
12. Frequency is selected to achieve the highest efficiency at full load as well as avoid saturation of the inductor. For instance, select 615kHz instead of 296kHz if 1V, 26A is required to avoid inductor saturation. Although better efficiency is obtained at 296kHz supporting 1V, 25A, higher frequency can be selected because less output capacitance is required to meet the transient response specification.

## 2. Specifications

### 2.1 Absolute Maximum Ratings

| Parameter                                                                                                    | Minimum      | Maximum | Unit        |
|--------------------------------------------------------------------------------------------------------------|--------------|---------|-------------|
| Input Supply Voltage, VIN Pin                                                                                | -0.3         | 17      | V           |
| Input Supply Voltage for Controller, VDD Pin                                                                 | -0.3         | 17      | V           |
| MOSFET Switch Node Voltage, SW1/2, SWD1/2 ( <a href="#">Note 13</a> )                                        | -0.3         | 25      | V           |
| MOSFET Driver Supply Voltage, VDRV, VDRV1 Pin                                                                | -0.3         | 6.0     | V           |
| Output Voltage, VOUT1/2 Pin                                                                                  | -0.3         | 6.0     | V           |
| <b>Internal Reference Supply Voltage</b>                                                                     |              |         |             |
| VR6 Pin                                                                                                      | -0.3         | 6.6     | V           |
| VR, VR5, VR55 Pin                                                                                            | -0.3         | 6.5     | V           |
| V25 Pin                                                                                                      | -0.3         | 3       | V           |
| Logic I/O Voltage for DDC, EN1/2, PG1/2, ASCR1/2, SA/CFG, SCL, SDA, SALRT, SYNC/OCF, SS/TRACK, VMON, VSET1/2 | -0.3         | 6.0     | V           |
| <b>Analog Input Voltages</b>                                                                                 |              |         |             |
| VSEN1P, VSEN2P, VTRKP                                                                                        | -0.3         | 6.0     | V           |
| VSEN1N, VSEN2N, VTRKN                                                                                        | -0.3         | 0.3     | V           |
| <b>ESD Rating</b>                                                                                            | <b>Value</b> |         | <b>Unit</b> |
| Human Body Model (Tested per JS-001-2014)                                                                    | 2            |         | kV          |
| Machine Model (Tested per JESD22-A115C)                                                                      | 200          |         | V           |
| Charged Device Model (Tested per JS-002-2014)                                                                | 750          |         | V           |
| Latch-Up (Tested per JESD78E; Class 2, Level A)                                                              | 100          |         | mA          |

Note:

13. Do not apply DC voltage higher than 17V to the pins.

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

### 2.2 Thermal Information

| Thermal Resistance (Typical)                       | $\theta_{JA}$ (°C/W) | $\theta_{JC}$ (°C/W) |
|----------------------------------------------------|----------------------|----------------------|
| 58 Ld HDA Package ( <a href="#">Notes 14, 15</a> ) | 5.3                  | 1.1                  |

Notes:

14.  $\theta_{JA}$  is defined by simulation in free air with the module mounted on an 8-layer evaluation board 4.7x4.8inch in size with 2oz Cu on all layers.

15. For  $\theta_{JC}$ , the "case temp" location is the center of the package underside.

| Parameter                                      | Minimum                       | Maximum | Unit |
|------------------------------------------------|-------------------------------|---------|------|
| Maximum Junction Temperature (Plastic Package) |                               | +125    | °C   |
| Storage Temperature Range                      | -55                           | +150    | °C   |
| Pb-Free Reflow Profile                         | see <a href="#">Figure 33</a> |         |      |

### 2.3 Recommended Operation Conditions

| Parameter                                                              | Minimum | Maximum | Unit |
|------------------------------------------------------------------------|---------|---------|------|
| Input Supply Voltage Range, VIN                                        | 4.5     | 14      | V    |
| Input Supply Voltage Range for Controller, VDD                         | 4.5     | 14      | V    |
| Output Voltage Range, VOUT                                             | 0.6     | 5       | V    |
| Output Current Range, IOUT(DC) Per Channel ( <a href="#">Note 18</a> ) | 0       | 30      | A    |
| Operating Junction Temperature Range, TJ                               | -40     | +125    | °C   |

## 2.4 Electrical Specifications

$V_{IN} = V_{DD} = 12V$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ . **Boldface limits apply across the operating temperature range,  $-40^{\circ}C$  to  $+85^{\circ}C$ .**

| Parameter                                                                             | Symbol                 | Test Conditions                                                                        | Min<br>( <a href="#">Note 16</a> ) | Typ         | Max<br>( <a href="#">Note 16</a> ) | Unit        |
|---------------------------------------------------------------------------------------|------------------------|----------------------------------------------------------------------------------------|------------------------------------|-------------|------------------------------------|-------------|
| <b>Input and Supply Characteristics</b>                                               |                        |                                                                                        |                                    |             |                                    |             |
| Input Supply Current for Controller                                                   | $I_{DD}$               | $V_{IN} = V_{DD} = 12V$ , $V_{OUT} = 0V$ , module not enabled                          |                                    | 40          | <b>50</b>                          | mA          |
| 6V Internal Reference Supply Voltage                                                  | $V_{R6}$               |                                                                                        | <b>5.5</b>                         | 6.1         | <b>6.6</b>                         | V           |
| 5V Internal Reference Supply                                                          | $V_{R5}$               | $I_{VR5} < 5mA$                                                                        | <b>4.5</b>                         | 5.2         | <b>5.5</b>                         | V           |
| 2.5V Internal Reference Supply                                                        | $V_{25}$               |                                                                                        | <b>2.25</b>                        | 2.5         | <b>2.75</b>                        | V           |
| Internal LDO Output Voltage                                                           | $V_{CC}$               |                                                                                        |                                    | 5.3         |                                    | V           |
| Internal LDO Output Current                                                           | $I_{VCC}$              | $V_{IN} = V_{DD} = 12V$ , $V_{CC}$ connected to VDRV, module enabled                   | <b>50</b>                          |             |                                    | mA          |
| Input Supply Voltage for Controller Read Back Resolution                              | $V_{DD\_READ\_RES}$    |                                                                                        |                                    | $\pm 20$    |                                    | mV          |
| Input Supply Voltage for Controller Read Back Total Error ( <a href="#">Note 19</a> ) | $V_{DD\_READ\_ERR}$    | PMBus Read                                                                             |                                    | $\pm 2$     |                                    | % FS        |
| <b>Output Characteristics</b>                                                         |                        |                                                                                        |                                    |             |                                    |             |
| Output Voltage Adjustment Range                                                       | $V_{OUT\_RANGE}$       |                                                                                        | <b>0.54</b>                        |             | <b>5.5</b>                         | V           |
| Output Voltage Set-Point Resolution                                                   | $V_{OUT\_RES}$         | Configured using PMBus                                                                 |                                    | $\pm 0.025$ |                                    | % $V_{OUT}$ |
| Output Voltage Set-Point Accuracy ( <a href="#">Notes 17, 19</a> )                    | $V_{OUT\_ACCY}$        | Includes line, load, and temperature ( $-20^{\circ}C \leq T_A \leq +85^{\circ}C$ )     | <b>-1.2</b>                        |             | <b>1.2</b>                         | %           |
| Output Voltage Read Back Resolution                                                   | $V_{OUT\_READ\_RES}$   |                                                                                        |                                    | $\pm 0.15$  |                                    | % FS        |
| Output Voltage Read Back Total Error ( <a href="#">Note 19</a> )                      | $V_{OUT\_READ\_ERR}$   | PMBus read                                                                             | <b>-2</b>                          |             | <b>2</b>                           | % FS        |
| Output Ripple Voltage                                                                 | $V_{OUT\_RIPPLE}$      | $V_{OUT} = 1.5V$ , $C_{OUT} = 1 \times 470\mu F$ POSCAP + $12 \times 100\mu F$ ceramic |                                    | 1           |                                    | %           |
| Output Current Read Back Resolution                                                   | $I_{OUT\_READ\_RES}$   | ISENSE_CONFIG default setting                                                          |                                    | 0.2         |                                    | A           |
| Output Current Range ( <a href="#">Note 18</a> )                                      | $I_{OUT\_RANGE}$       | Per channel                                                                            |                                    |             | <b>30</b>                          | A           |
| Output Current Read Back Total Error                                                  | $I_{OUT\_READ\_ERR}$   | PMBus read at max load $V_{OUT} = 1.5V$                                                |                                    | $\pm 3$     |                                    | A           |
| <b>Soft-Start and Sequencing</b>                                                      |                        |                                                                                        |                                    |             |                                    |             |
| Delay Time from Enable to $V_{OUT}$ Rise                                              | $t_{ON\_DELAY}$        | Configured using PMBus                                                                 | <b>2</b>                           |             | <b>300</b>                         | ms          |
| $t_{ON\_DELAY}$ Accuracy                                                              | $t_{ON\_DELAY\_ACCY}$  |                                                                                        |                                    | $\pm 2$     |                                    | ms          |
| Output Voltage Ramp-Up Time                                                           | $t_{ON\_RISE}$         | Configured using PMBus                                                                 | <b>0.5</b>                         |             | <b>120</b>                         | ms          |
| Output Voltage Ramp-Up Time Accuracy                                                  | $t_{ON\_RISE\_ACCY}$   |                                                                                        |                                    | $\pm 250$   |                                    | $\mu s$     |
| Delay Time from Disable to $V_{OUT}$ Fall                                             | $t_{OFF\_DELAY}$       | Configured using PMBus                                                                 | <b>2</b>                           |             | <b>300</b>                         | ms          |
| $t_{OFF\_DELAY}$ Accuracy                                                             | $t_{OFF\_DELAY\_ACCY}$ |                                                                                        |                                    | $\pm 2$     |                                    | ms          |

$V_{IN} = V_{DD} = 12V$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ . **Boldface limits apply across the operating temperature range,  $-40^{\circ}C$  to  $+85^{\circ}C$ .** (Continued)

| Parameter                                                                  | Symbol                  | Test Conditions                                      | Min<br>( <a href="#">Note 16</a> ) | Typ           | Max<br>( <a href="#">Note 16</a> ) | Unit        |
|----------------------------------------------------------------------------|-------------------------|------------------------------------------------------|------------------------------------|---------------|------------------------------------|-------------|
| Output Voltage Fall Time                                                   | $t_{OFF\_FALL}$         | Configured using PMBus                               | <b>0.5</b>                         |               | <b>120</b>                         | ms          |
| Output Voltage Fall Time Accuracy                                          | $t_{ON\_FALL\_ACCY}$    |                                                      |                                    | $\pm 250$     |                                    | $\mu s$     |
| <b>Power-Good</b>                                                          |                         |                                                      |                                    |               |                                    |             |
| Power-Good Delay                                                           | $V_{PG\_DELAY}$         | Configured using PMBus                               | <b>0</b>                           |               | <b>5000</b>                        | ms          |
| <b>Temperature Sense</b>                                                   |                         |                                                      |                                    |               |                                    |             |
| Temperature Sense Range                                                    | $T_{SENSE\_RANGE}$      | Configurable using PMBus                             | <b>-50</b>                         |               | <b>150</b>                         | $^{\circ}C$ |
| Internal Temperature Sensor Accuracy                                       | $INT\_TEMP_{ACCY}$      | Tested at $+100^{\circ}C$                            | -5                                 |               | 5                                  | $^{\circ}C$ |
| <b>Fault Protection</b>                                                    |                         |                                                      |                                    |               |                                    |             |
| $V_{DD}$ Undervoltage Threshold Range                                      | $V_{DD\_UVLO\_RANGE}$   | Measured internally                                  | <b>4.18</b>                        |               | <b>16</b>                          | V           |
| $V_{DD}$ Undervoltage Threshold Accuracy ( <a href="#">Note 19</a> )       | $V_{DD\_UVLO\_ACCY}$    |                                                      |                                    | $\pm 2$       |                                    | %FS         |
| $V_{DD}$ Undervoltage Response Time                                        | $V_{DD\_UVLO\_DELAY}$   |                                                      |                                    | 10            |                                    | $\mu s$     |
| $V_{OUT}$ Overvoltage Threshold Range                                      | $V_{OUT\_OV\_RANGE}$    | Factory default                                      |                                    | $1.15V_{OUT}$ |                                    | V           |
|                                                                            |                         | Configured using PMBus                               | <b><math>1.05V_{OUT}</math></b>    |               | <b><math>V_{OUT\_MAX}</math></b>   | V           |
| $V_{OUT}$ Undervoltage Threshold Range                                     | $V_{OUT\_UV\_RANGE}$    | Factory default                                      |                                    | $0.85V_{OUT}$ |                                    | V           |
|                                                                            |                         | Configured using PMBus                               | <b>0</b>                           |               | <b><math>0.95V_{OUT}</math></b>    | V           |
| $V_{OUT}$ OV/UV Threshold Accuracy ( <a href="#">Note 17</a> )             | $V_{OUT\_OV/UV\_ACCY}$  |                                                      | <b>-2</b>                          |               | <b>2</b>                           | %           |
| $V_{OUT}$ OV/UV Response Time                                              | $V_{OUT\_OV/UV\_DELAY}$ |                                                      |                                    | 10            |                                    | $\mu s$     |
| Output Current Limit Set-Point Accuracy ( <a href="#">Note 19</a> )        | $I_{LIMIT\_ACCY}$       | Tested at $I_{OUT\_AVG\_OC\_FAULT\_LIMIT} = 35A$     |                                    | $\pm 10$      |                                    | % FS        |
| Over-temperature Protection Threshold<br>(Controller Junction Temperature) | $T_{JUNCTION}$          | Factory default                                      |                                    | 115           |                                    | $^{\circ}C$ |
|                                                                            |                         | Configured using PMBus                               | <b>-40</b>                         |               | <b>115</b>                         | $^{\circ}C$ |
| Thermal Protection Hysteresis                                              | $T_{JUNCTION\_HYS}$     |                                                      |                                    | 15            |                                    | $^{\circ}C$ |
| <b>Oscillator and Switching Characteristics</b>                            |                         |                                                      |                                    |               |                                    |             |
| Switching Frequency Range                                                  | $f_{SW\_RANGE}$         |                                                      | <b>296</b>                         |               | <b>1067</b>                        | kHz         |
| Switching Frequency Set-Point Accuracy                                     | $f_{SW\_ACCY}$          |                                                      | <b>-5</b>                          |               | <b>5</b>                           | %           |
| Minimum Pulse Width Required from External SYNC Clock                      | $EXT\_SYNC_{PW}$        | Measured at 50% amplitude                            | <b>150</b>                         |               |                                    | ns          |
| Drift Tolerance for External SYNC Clock                                    | $EXT\_SYNC_{DRIFT}$     | External SYNC clock equal to 500kHz is not supported | <b>-10</b>                         |               | <b>10</b>                          | %           |

$V_{IN} = V_{DD} = 12V$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ . **Boldface limits apply across the operating temperature range,  $-40^{\circ}C$  to  $+85^{\circ}C$ .** (Continued)

| Parameter                                    | Symbol                 | Test Conditions                                                                                   | Min<br>( <a href="#">Note 16</a> ) | Typ | Max<br>( <a href="#">Note 16</a> ) | Unit |
|----------------------------------------------|------------------------|---------------------------------------------------------------------------------------------------|------------------------------------|-----|------------------------------------|------|
| <b>Logic Input/Output Characteristics</b>    |                        |                                                                                                   |                                    |     |                                    |      |
| Bias Current at the Logic Input Pins         | $I_{LOGIC\_BIAS}$      | DDC, EN1/2, PG1/2, SA/CFG, SCL, SDA, ASCR1/2, SS/TRACK, SALRT, SYNC/OCP, $V_{MON}$ , $V_{SET1/2}$ | <b>-100</b>                        |     | <b>+100</b>                        | nA   |
| Logic Input Low Threshold Voltage            | $V_{LOGIC\_IN\_LOW}$   |                                                                                                   |                                    |     | <b>0.8</b>                         | V    |
| Logic Input High Threshold Voltage           | $V_{LOGIC\_IN\_HIGH}$  |                                                                                                   | <b>2.0</b>                         |     |                                    | V    |
| Logic Output Low Threshold Voltage           | $V_{LOGIC\_OUT\_LOW}$  | 2mA sinking                                                                                       |                                    |     | <b>0.5</b>                         | V    |
| Logic Output High Threshold Voltage          | $V_{LOGIC\_OUT\_HIGH}$ | 2mA sourcing                                                                                      | <b>2.25</b>                        |     |                                    | V    |
| <b>PMBus Interface Timing Characteristic</b> |                        |                                                                                                   |                                    |     |                                    |      |
| PMBus Operating Frequency                    | $f_{SMB}$              |                                                                                                   | <b>100</b>                         |     | <b>400</b>                         | kHz  |

Notes:

16. Compliance to datasheet limits is assured by one or more methods: Production test, characterization, and/or design. Controller is independently tested before module assembly.
17.  $V_{OUT}$  measured at the termination of the VSEN1/2P and VSEN1/2N sense points.
18. The MAX load current is determined by the thermal ["Derating Curves" on page 20](#).
19. "FS" stands for full scale of recommended maximum operation range.

### 3. Typical Performance Curves

#### 3.1 Efficiency Performance

Operating condition:  $T_A = +25^\circ\text{C}$ , no air flow.  $C_{OUT} = 1 \times 470\mu\text{F}$  POSCAP +  $12 \times 100\mu\text{F}$  Ceramic. Typical values are used unless otherwise noted. The efficiency curves were measured on the evaluation board. For test conditions, refer to [Table 2 on page 10](#).

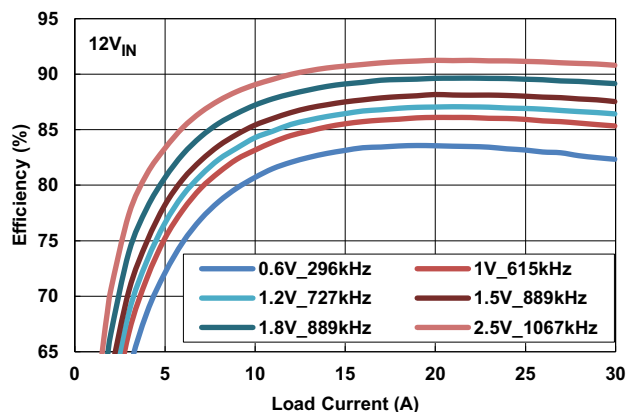


Figure 5. Single Channel Efficiency vs Output Current

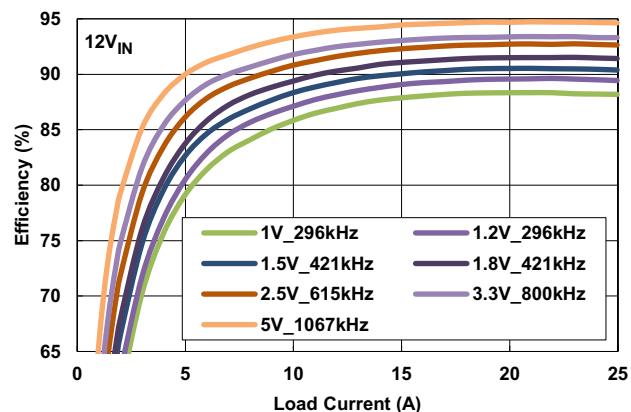


Figure 6. Single Channel Efficiency vs Output Current

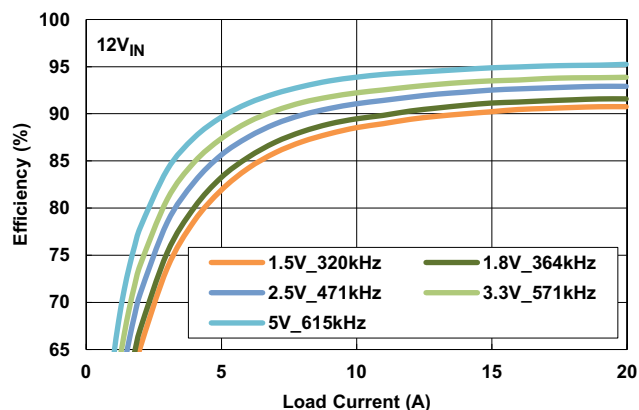


Figure 7. Single Channel Efficiency vs Output Current

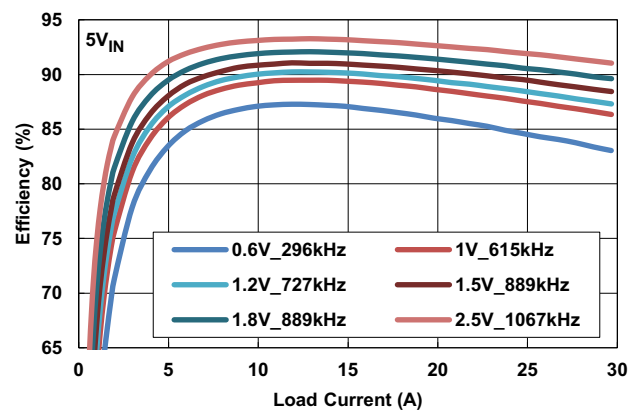


Figure 8. Single Channel Efficiency vs Output Current

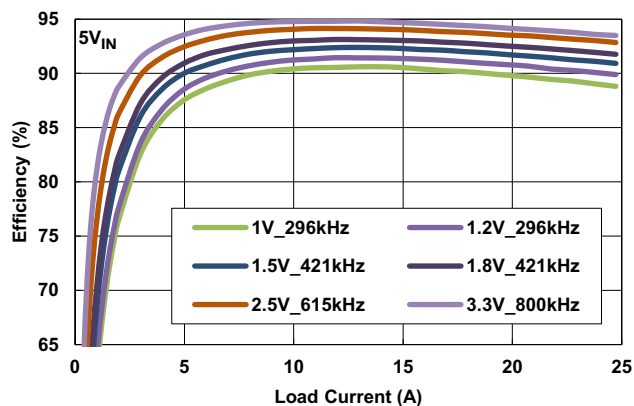


Figure 9. Single Channel Efficiency vs Output Current

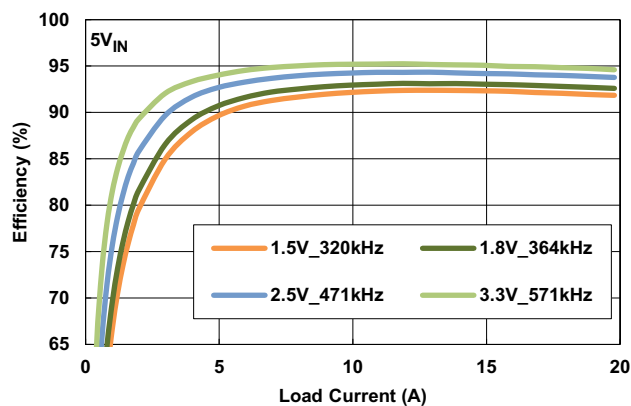


Figure 10. Single Channel Efficiency vs Output Current



### 3.2 Startup and Shutdown

Operating condition:  $T_A = +25^\circ\text{C}$ , no air flow.  $C_{OUT} = 1 \times 470\mu\text{F POSCAP} + 12 \times 100\mu\text{F Ceramic}$ . Typical values are used unless otherwise noted.

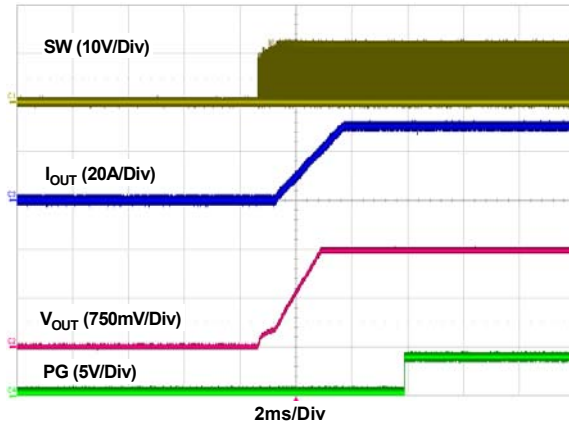


Figure 11. Single Channel Startup  $12V_{IN}$ ,  $1.5V_{OUT}$ , 30A

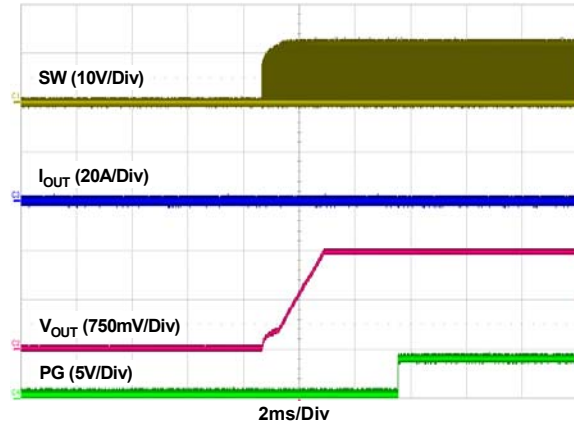


Figure 12. Single Channel Startup  $12V_{IN}$ ,  $1.5V_{OUT}$ , 0A

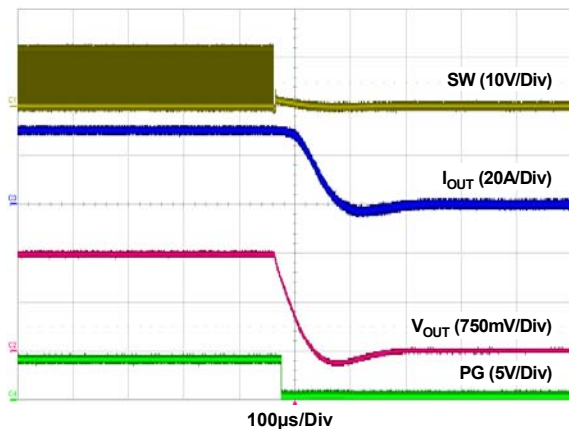


Figure 13. Single Channel Shutdown  $12V_{IN}$ ,  $1.5V_{OUT}$ , 30A

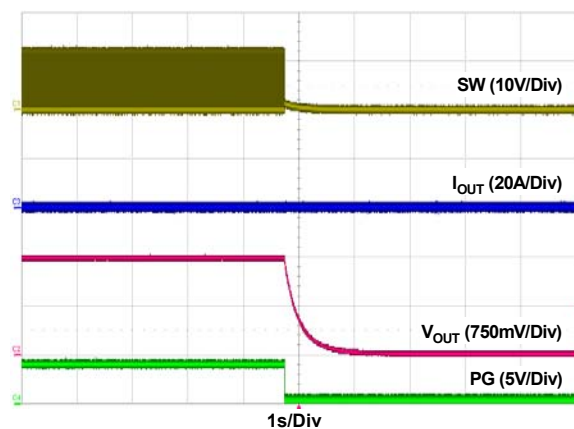


Figure 14. Single Channel Shutdown  $12V_{IN}$ ,  $1.5V_{OUT}$ , 0A

### 3.3 Derating Curves

All of the following curves were plotted at  $T_J = +125^{\circ}\text{C}$ . The derating curves were measured on the evaluation board. For test conditions, refer to [Table 2 on page 10](#). Load current is applied per channel, two channels are operating at the same time.

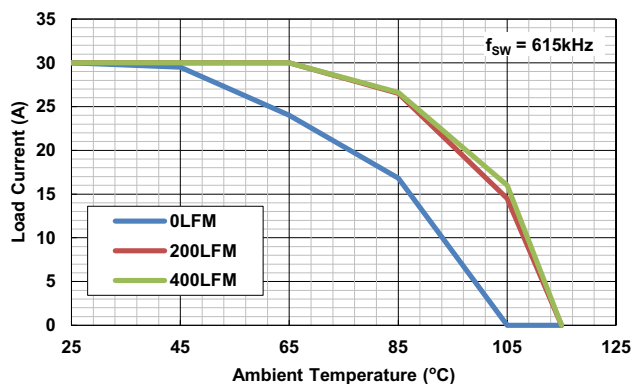


Figure 15. 12V<sub>IN</sub> to 1V<sub>OUT</sub>

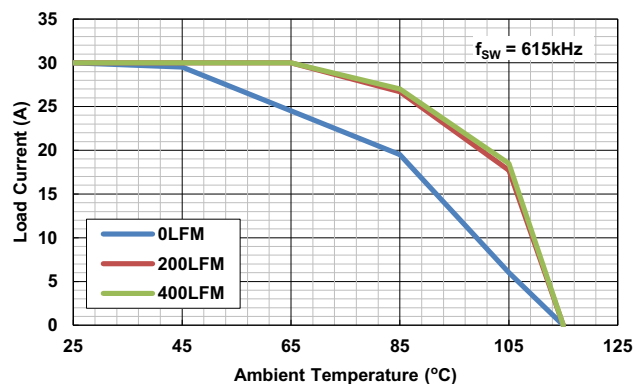


Figure 16. 5V<sub>IN</sub> to 1V<sub>OUT</sub>

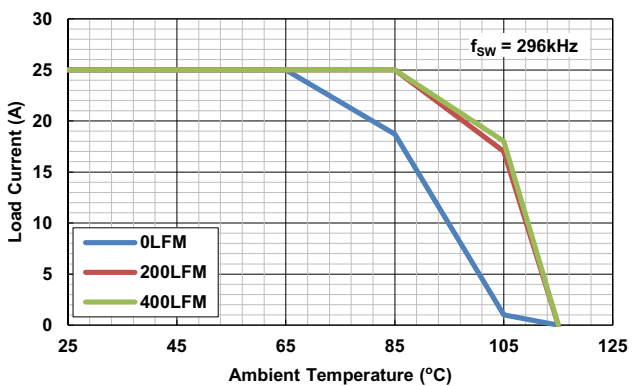


Figure 17. 12V<sub>IN</sub> to 1V<sub>OUT</sub>

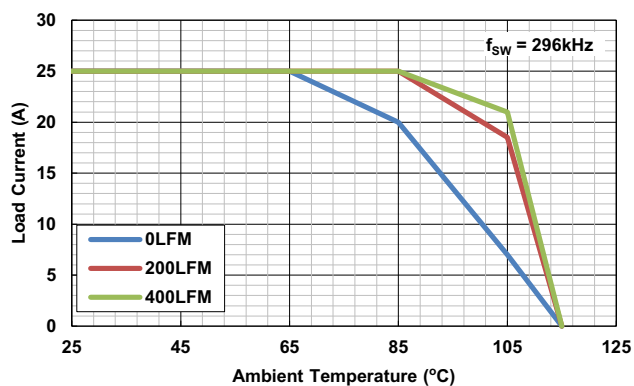


Figure 18. 5V<sub>IN</sub> to 1V<sub>OUT</sub>

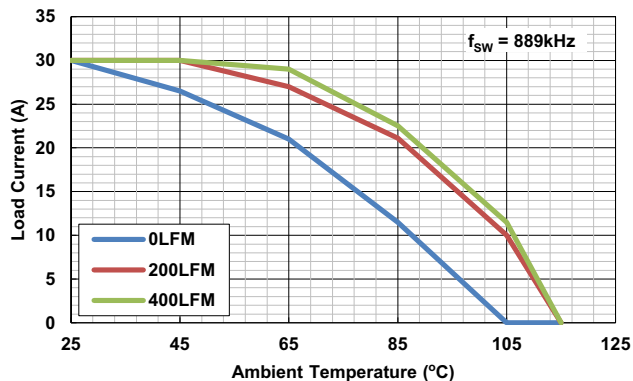


Figure 19. 12V<sub>IN</sub> to 1.5V<sub>OUT</sub>

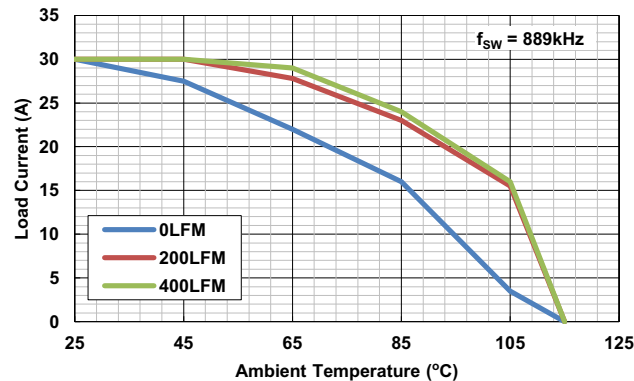
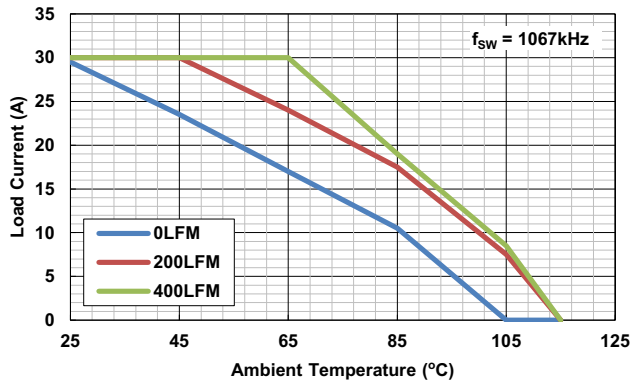
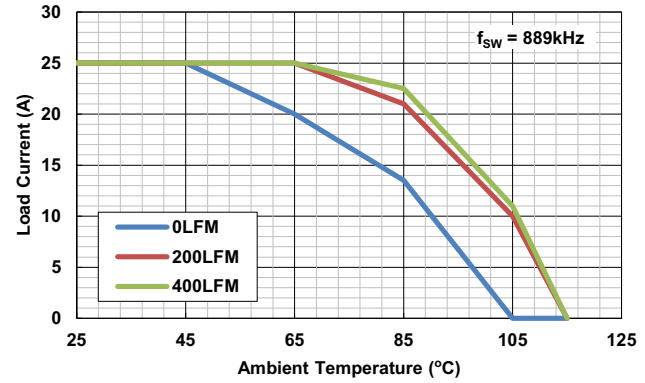
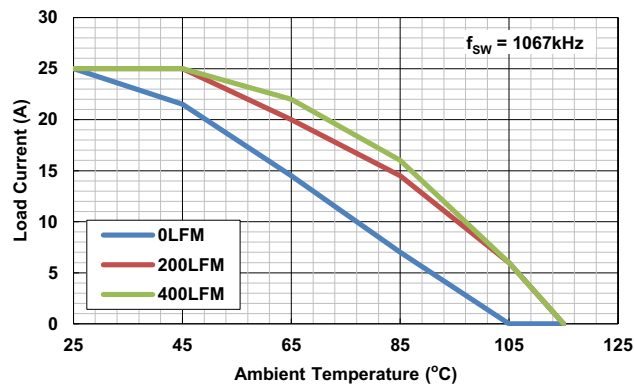


Figure 20. 5V<sub>IN</sub> to 1.5V<sub>OUT</sub>

All of the following curves were plotted at  $T_J = +125^\circ\text{C}$ . The derating curves were measured on the evaluation board. For test conditions, refer to [Table 2 on page 10](#). Load current is applied per channel, two channels are operating at the same time. **(Continued)**

Figure 21. 12V<sub>IN</sub> to 2.5V<sub>OUT</sub>Figure 22. 5V<sub>IN</sub> to 2.5V<sub>OUT</sub>Figure 23. 12V<sub>IN</sub> to 5V<sub>OUT</sub>

### 3.4 Transient Response Performance

Operating condition:  $T_A = +25^\circ\text{C}$ , no air flow. Refer to [Table 2 on page 10](#) for output capacitor and ASCR settings. Typical values are used unless otherwise noted.

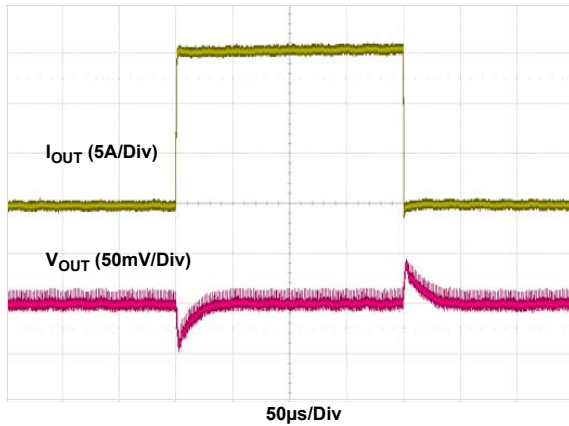


Figure 24. 0A-15A,  $>10\text{A}/\mu\text{s}$ ,  $12\text{V}_{\text{IN}}$ ,  $1\text{V}_{\text{OUT}}$ , 615kHz

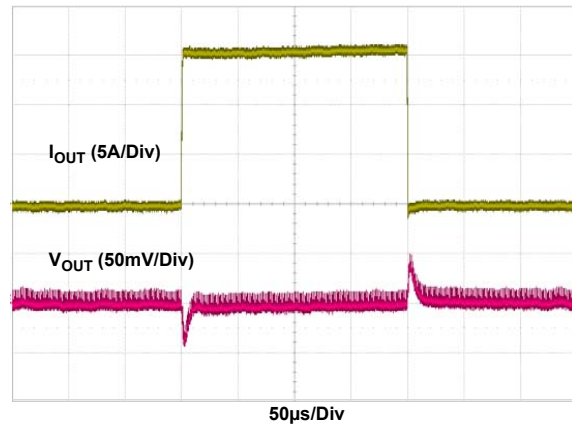


Figure 25. 0A-15A,  $>10\text{A}/\mu\text{s}$ ,  $12\text{V}_{\text{IN}}$ ,  $1.5\text{V}_{\text{OUT}}$ , 889kHz

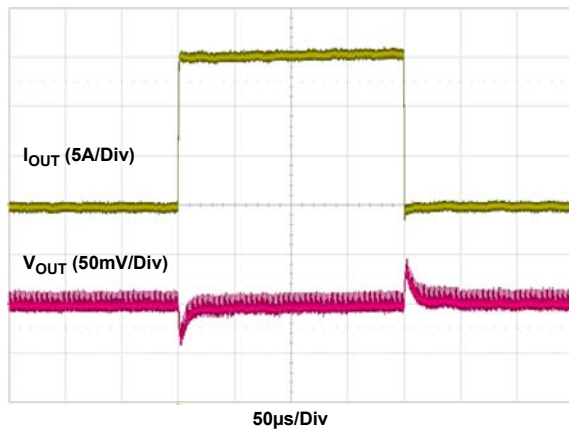


Figure 26. 0A-15A,  $>10\text{A}/\mu\text{s}$ ,  $12\text{V}_{\text{IN}}$ ,  $1.8\text{V}_{\text{OUT}}$ , 889kHz

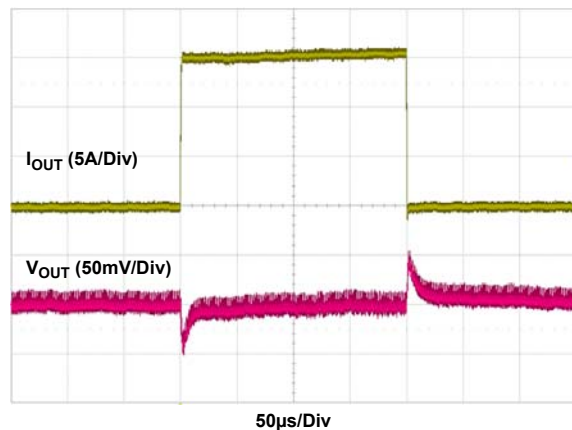


Figure 27. 0A-15A,  $>10\text{A}/\mu\text{s}$ ,  $12\text{V}_{\text{IN}}$ ,  $2.5\text{V}_{\text{OUT}}$ , 1067kHz

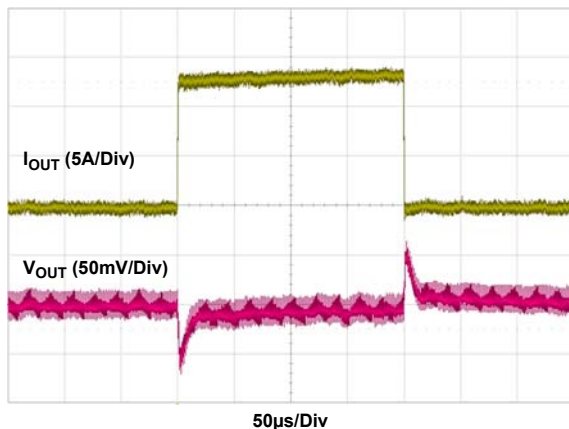


Figure 28. 0A-12.5A,  $>10\text{A}/\mu\text{s}$ ,  $12\text{V}_{\text{IN}}$ ,  $3.3\text{V}_{\text{OUT}}$ , 800kHz

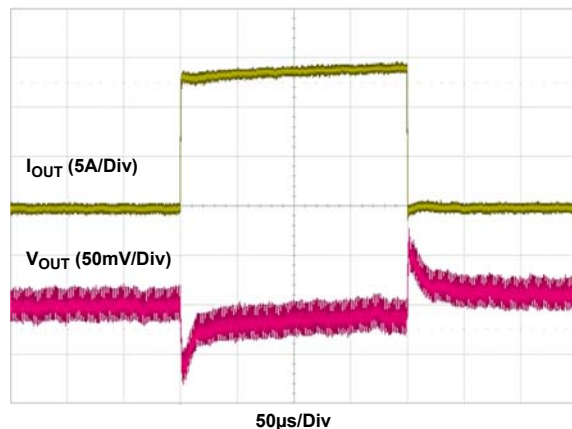


Figure 29. 0A-12.5A,  $>10\text{A}/\mu\text{s}$ ,  $12\text{V}_{\text{IN}}$ ,  $5\text{V}_{\text{OUT}}$ , 1067kHz

## 4. Functional Description

### 4.1 SMBus Communications

The ISL8274M provides a PMBus digital interface that enables the user to configure all aspects of the module operation as well as monitor the input and output parameters. The ISL8274M can be used with any SMBus host device. In addition, the module is compatible with PMBus Power System Management Protocol Specification Parts I and II version 1.2. The ISL8274M accepts most standard PMBus commands. When configuring the device using PMBus commands, it is recommended that the enable pin is tied to SGND.

The SMBus device address is the only parameter that must be set by the external pins. All other device parameters can be set using PMBus commands.

The ISL8274M can operate without the PMBus in pin-strap mode with configurations programmed by pin-strap resistors, such as output voltage, ASCR setting, switching frequency, OCP limit, device SMBus address, input UVLO, soft-start/stop, and tracking.

### 4.2 Output Voltage Selection

The output voltages of both channels may be set to a voltage between 0.6V and 5V if the input voltage is higher than the desired output voltage by an amount sufficient to maintain regulation.

The VSET1/2 pins are used to set the output voltage VOUT1/2 to levels as shown in [Table 3](#). The RSET1/2 resistor is placed between the VSET1/2 pins and SGND. A standard 1% resistor is required.

**Table 3. Output Voltage Resistor Settings**

| VOUT1/2 (V) | RSET1/2 (kΩ) |
|-------------|--------------|
| 1           | LOW          |
| 1.5         | OPEN         |
| 3.3         | HIGH         |
| 0.6         | 10           |
| 0.675       | 11           |
| 0.7         | 12.1         |
| 0.72        | 13.3         |
| 0.75        | 14.7         |
| 0.8         | 16.2         |
| 0.85        | 17.8         |
| 0.9         | 19.6         |
| 0.93        | 21.5         |
| 0.95        | 23.7         |
| 0.98        | 26.1         |
| 1.03        | 28.7         |
| 1.05        | 31.6         |
| 1.1         | 34.8         |
| 1.12        | 38.3         |
| 1.15        | 42.2         |
| 1.2         | 46.4         |
| 1.25        | 51.1         |
| 1.3         | 56.2         |
| 1.35        | 61.9         |

**Table 3. Output Voltage Resistor Settings (Continued)**

| VOUT1/2 (V) | RSET1/2 (kΩ) |
|-------------|--------------|
| 1.4         | 68.1         |
| 1.65        | 75           |
| 1.8         | 82.5         |
| 1.85        | 90.9         |
| 2           | 100          |
| 2.4         | 110          |
| 2.5         | 121          |
| 2.8         | 133          |
| 3           | 147          |
| 3.6         | 162          |
| 5           | 178          |

The output voltage may also be set to any value between 0.6V and 5V using the PMBus command VOUT\_COMMAND. This device supports dynamic voltage scaling by allowing change to the output voltage set point during regulation. The voltage transition rate is specified by the PMBus command VOUT\_TRANSITION\_RATE.

By default,  $V_{OUT\_MAX}$  is set to 110% of  $V_{OUT}$  set by the pin-strap resistor, which can be changed to any value up to 5.5V by the PMBus Command VOUT\_MAX.

### 4.3 Soft-Start, Stop Delay, and Ramp Times

The ISL8274M follows an internal start-up procedure after power is applied to the VDD pin. The module requires approximately 60ms to 70ms to check for specific values stored in its internal memory and programmed by pin-strap resistors. Once this process is completed, the device is ready to accept commands through the PMBus interface and the module is ready to be enabled. If the module is to be synchronized to an external clock source, the clock frequency must be stable before asserting the EN pin.

It may be necessary to set a delay from when an enable signal is received until the output voltage starts to ramp to its target value. In addition, the designer may wish to precisely set the time required for  $V_{OUT}$  to ramp to its target value after the delay period has expired. These features can be used as part of an overall inrush current management strategy or to precisely control how fast a load IC is turned on. The ISL8274M gives the system designer several options for precisely and independently controlling both the delay and ramp time periods. The soft-start delay period begins when the EN pin is asserted and ends when the delay time expires.

The soft-start delay and ramp-up time can be programmed to custom values using the PMBus commands TON\_DELAY and TON\_RISE. When the delay time is set to 0ms, the device begins its ramp-up after the internal circuitry has initialized (approximately 2ms). When the soft-start ramp period is set to 0ms, the output ramps up as quickly as the output load capacitance and loop settings allow. It is generally recommended to set the soft-start ramp to a value greater than 2ms to prevent inadvertent fault conditions due to excessive inrush current.

Similar to the soft-start delay and ramp-up time, the delay and ramp down time for soft-stop/off can be programmed using the PMBus commands TOFF\_DELAY and TOFF\_FALL. In addition, the module can be configured as “immediate off” using the command ON\_OFF\_CONFIG, so that the internal MOSFETs are turned off immediately after the delay time expires.

The SS/TRACK pin can be used to program the soft-start/stop delay time and ramp time to some typical values as well as enable/disable the tracking function shown in [Table 4 on page 23](#).

Table 4. Soft-Start/Stop and Tracking Resistor Settings

| TON_DELAY<br>TOFF_DELAY (ms) |     | TON_RISE<br>TOFF_FALL (ms) |     | Tracking   |            | R (kΩ) |
|------------------------------|-----|----------------------------|-----|------------|------------|--------|
| Ch1                          | Ch2 | Ch1                        | Ch2 | Ch1        | Ch2        |        |
| 5                            | 5   | 2                          | 2   | No         | No         | LOW    |
| 5                            | 5   | 2                          | 5   | No         | No         | OPEN   |
| 5                            | 5   | 5                          | 2   | No         | No         | HIGH   |
| 5                            | 5   | 5                          | 5   | No         | No         | 10     |
| 5                            | 10  | 2                          | 2   | No         | No         | 11     |
| 5                            | 10  | 2                          | 5   | No         | No         | 12.1   |
| 5                            | 10  | 5                          | 2   | No         | No         | 13.3   |
| 5                            | 10  | 5                          | 5   | No         | No         | 14.7   |
| 10                           | 5   | 2                          | 2   | No         | No         | 16.2   |
| 10                           | 5   | 2                          | 5   | No         | No         | 17.8   |
| 10                           | 5   | 5                          | 2   | No         | No         | 19.6   |
| 10                           | 5   | 5                          | 5   | No         | No         | 21.5   |
| 20                           | 5   | 2                          | 2   | No         | No         | 23.7   |
| 20                           | 5   | 5                          | 5   | No         | No         | 26.1   |
| 5                            | 20  | 2                          | 2   | No         | No         | 28.7   |
| 5                            | 20  | 2                          | 5   | No         | No         | 31.6   |
| 5                            | 20  | 5                          | 2   | No         | No         | 34.8   |
| 5                            | 20  | 5                          | 5   | No         | No         | 38.3   |
| 5                            | N/A | 2                          | N/A | No         | Track 100% | 42.2   |
| 5                            | N/A | 2                          | N/A | No         | Track 50%  | 46.4   |
| 5                            | N/A | 5                          | N/A | No         | Track 100% | 51.1   |
| 5                            | N/A | 5                          | N/A | No         | Track 50%  | 56.2   |
| 10                           | N/A | 2                          | N/A | No         | Track 100% | 61.9   |
| 10                           | N/A | 2                          | N/A | No         | Track 50%  | 68.1   |
| 10                           | N/A | 5                          | N/A | No         | Track 100% | 75     |
| 10                           | N/A | 5                          | N/A | No         | Track 50%  | 82.5   |
| N/A                          | 5   | N/A                        | 2   | Track 100% | No         | 90.9   |
| N/A                          | 5   | N/A                        | 2   | Track 50%  | No         | 100    |
| N/A                          | 5   | N/A                        | 5   | Track 100% | No         | 110    |
| N/A                          | 5   | N/A                        | 5   | Track 50%  | No         | 121    |
| N/A                          | 10  | N/A                        | 2   | Track 100% | No         | 133    |
| N/A                          | 10  | N/A                        | 2   | Track 50%  | No         | 147    |
| N/A                          | 10  | N/A                        | 5   | Track 100% | No         | 162    |
| N/A                          | 10  | N/A                        | 5   | Track 50%  | No         | 178    |

## 4.4 Voltage Tracking

Numerous high performance systems place stringent demands on the order in which the power supply voltages are turned on. This is particularly true when powering FPGAs, ASICs, and other advanced processor devices that require multiple supply voltages to power a single die. In most cases, the I/O interface operates at a higher voltage than the core and therefore, the core supply voltage must not exceed the I/O supply voltage according to the manufacturers' specifications.

The ISL8274M integrates a tracking scheme that allows one of its outputs (Channel 1 or Channel 2) to track a voltage that is applied to the VTRKP and VTRKN pins with no external components required. The VTRKP and VTRKN pins are analog inputs that, when the tracking mode is enabled, configure the voltage applied to the VTRKP and VTRKN pins to act as a reference for the device's output regulation.

[Figure 30](#) illustrates the typical connection and the two tracking modes:

- **Coincident** - This mode configures the ISL8274M to ramp its output voltage at the same rate as the voltage applied to the VTRK pin until it reaches its desired output voltage. The device that is tracking another output voltage (slave) must be set to its desired steady-state output voltage.
- **Ratio-metric** - This mode configures the ISL8274M to ramp its output voltage at a rate that is a percentage of the voltage applied to the VTRKP and VTRKN pins. The default setting is 50%, but an external resistor string can be used to configure a different tracking ratio. The device that is tracking another output voltage (slave) must be set to its desired steady-state output voltage.

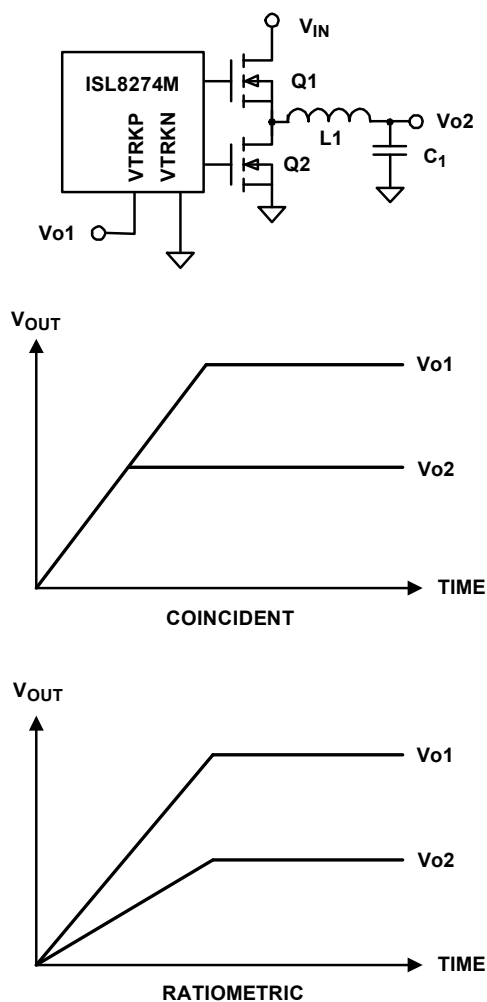


Figure 30. Tracking Modes



The master ISL8274M device in a tracking group is defined as the device that has the highest target output voltage within the group. This master device will control the ramp rate of all tracking devices and is not configured for tracking mode. The maximum tracking rise time is 1V/ms. The slave device must be enabled before the master. Any device that is configured for tracking mode will ignore its TON\_DELAY and TON\_RISE settings and its output will take on the turn-on/turn-off characteristics of the reference voltage present at the VTRKP and VTRKN pins. Tracking mode can be configured by using the TRACK\_CONFIG command.

The VOUT\_COMMAND needs to be set the same as the target tracking voltage when tracking is enabled. For example, the VOUT\_COMMAND of the Page1 (VOUT2 which enables the tracking) needs to set to 1V if tracking 100% is selected and a ramp of 1V is applied to VTRKP and VTRKN. The VOUT\_COMMAND of Page 1 (VOUT2 which enables the tracking) needs to set to 1V if tracking 50% is selected and a ramp of 2V is applied to VTRKP and VTRKN. In Tracking mode, the minimum voltage that can be tracked is ~200mV.

#### 4.5 Power-Good

The ISL8274M provides a Power-Good (PG) signal that indicates the output voltage is within a specified tolerance of its target level and no fault condition exists. By default, the PG pin asserts if the output is within 10% of the target voltage. This limit may be changed using the PMBus command POWER\_GOOD\_ON.

A PG delay period is defined as the time from when all conditions within the ISL8274M for asserting PG are met to when the PG pin is actually asserted. This feature is commonly used instead of using an external reset controller to control external digital logic. A PG delay can be programmed using the PMBus command POWER\_GOOD\_DELAY.

#### 4.6 Switching Frequency and PLL

The device's switching frequency is set from 296kHz to 1067kHz using the pin-strap method (combined with the average OCP limit setting) as shown in [Table 5](#), or by using the PMBus command FREQUENCY\_SWITCH. The ISL8274M incorporates an internal Phase-Locked Loop (PLL) to clock the internal circuitry. The PLL can be driven by an external clock source connected to the SYNC pin. It is recommended that when using an external clock, the same frequency should be set in the FREQUENCY\_SWITCH command. If the external clock is lost, the module will automatically switch to the internal clock. When using the internal oscillator, the SYNC pin can be configured as a clock source and as an external sync to other modules. Refer to [“SYNC\\_CONFIG \(E9h\)” on page 67](#) for more information.

**Table 5. Switching Frequency and OCP Limit Resistor Setting**

| SYNC/OCP |           | OCP Avg |         |
|----------|-----------|---------|---------|
| R (kΩ)   | Fsw (KHz) | Ch1 (A) | Ch2 (A) |
| LOW      | 296       | 35      | 35      |
| OPEN     | 889       | 35      | 35      |
| HIGH     | 1067      | 35      | 35      |
| 10       | 296       | 30      | 35      |
| 11       | 296       | 30      | 30      |
| 12.1     | 296       | 25      | 35      |
| 13.3     | 296       | 25      | 30      |
| 14.7     | 296       | 25      | 25      |
| 16.2     | 320       | 25      | 35      |
| 17.8     | 320       | 25      | 30      |
| 19.6     | 320       | 25      | 25      |
| 21.5     | 320       | 20      | 30      |
| 23.7     | 320       | 20      | 25      |
| 26.1     | 364       | 25      | 35      |

**Table 5. Switching Frequency and OCP Limit Resistor Setting (Continued)**

| SYNC/OCP        |           | OCP Avg |         |
|-----------------|-----------|---------|---------|
| R (k $\Omega$ ) | Fsw (KHz) | Ch1 (A) | Ch2 (A) |
| 28.7            | 364       | 25      | 30      |
| 31.6            | 364       | 20      | 30      |
| 34.8            | 421       | 30      | 35      |
| 38.3            | 421       | 30      | 30      |
| 42.2            | 471       | 25      | 35      |
| 46.4            | 471       | 25      | 30      |
| 51.1            | 471       | 20      | 35      |
| 56.2            | 571       | 25      | 35      |
| 61.9            | 571       | 25      | 30      |
| 68.1            | 571       | 20      | 35      |
| 75              | 571       | 20      | 30      |
| 82.5            | 615       | 35      | 35      |
| 90.9            | 615       | 35      | 30      |
| 100             | 615       | 30      | 30      |
| 110             | 615       | 25      | 35      |
| 121             | 615       | 25      | 30      |
| 133             | 615       | 25      | 25      |
| 147             | 727       | 35      | 35      |
| 162             | 800       | 30      | 35      |
| 178             | 800       | 30      | 30      |

## 4.7 Output Overcurrent Protection

The ISL8274M is protected from damage if the output is shorted to ground or if an overload condition is imposed on the output. Average output overcurrent fault threshold can be programmed by the PMBus command IOUT\_AVG\_OC\_FAULT\_LIMIT while the peak output overcurrent fault threshold can be programmed by the PMBus command IOUT\_OC\_FAULT\_LIMIT. The default response from an average overcurrent fault is an immediate shutdown without retry. A continuous retry can be enabled using the PMBus command MFR\_IOUT\_OC\_FAULT\_RESPONSE. A hard bound of 50A is applied to the peak overcurrent limit.

The average OCP limit can be set by the SYNC/OCP pin strap as well. Refer to [Table 5 on page 25](#) for more information.

## 4.8 Loop Compensation

The module loop response is programmable through the PMBus command ASCR\_CONFIG or by using the pin-strap method (ASCR1/2 pins) according to [Table 6](#). The ISL8274M uses the ChargeMode control algorithm that responds to the output current changes within a single PWM switching cycle, achieving a smaller total output voltage variation with less output capacitance than traditional PWM controllers.

**Table 6. ASCR Resistor Setting**

| ASCR Gain | ASCR Residual | R (kΩ) |
|-----------|---------------|--------|
| 350       | 110           | LOW    |
| 525       | 90            | OPEN   |
| 475       | 80            | HIGH   |
| 100       | 90            | 10     |
| 100       | 100           | 11     |
| 120       | 90            | 12.1   |
| 120       | 100           | 13.3   |
| 140       | 90            | 14.7   |
| 140       | 100           | 16.2   |
| 140       | 110           | 17.8   |
| 150       | 90            | 19.6   |
| 150       | 100           | 21.5   |
| 160       | 70            | 23.7   |
| 160       | 90            | 26.1   |
| 175       | 80            | 28.7   |
| 175       | 90            | 31.6   |
| 200       | 90            | 34.8   |
| 200       | 100           | 38.3   |
| 200       | 110           | 42.2   |
| 225       | 80            | 46.4   |
| 225       | 90            | 51.1   |
| 250       | 80            | 56.2   |
| 250       | 100           | 61.9   |
| 275       | 90            | 68.1   |
| 275       | 100           | 75     |
| 300       | 70            | 82.5   |
| 300       | 90            | 90.9   |

Table 6. ASCR Resistor Setting (Continued)

| ASCR Gain | ASCR Residual | R (kΩ) |
|-----------|---------------|--------|
| 350       | 100           | 100    |
| 450       | 100           | 110    |
| 450       | 110           | 121    |
| 500       | 70            | 133    |
| 500       | 90            | 147    |
| 600       | 100           | 162    |
| 600       | 110           | 178    |

#### 4.9 SMBus Module Address Selection

Each module must have its own unique serial address to distinguish between other devices on the bus. The module address is set by connecting a resistor between pins SA/CFG and SGND. The SA/CFG pin also defines the input undervoltage lockout limit. The input Undervoltage Lockout (UVLO) prevents the ISL8274M from operating when the input falls below a preset threshold, indicating the input supply is out of its specified range. The UVLO threshold ( $V_{UVLO}$ ) can be set between 4.18V and 16V by using the PMBus command VIN\_UV\_FAULT\_LIMIT.

[Table 7](#) lists the available module addresses.

A fault response to an input undervoltage fault can be programmed by the PMBus command VIN\_UV\_FAULT\_RESPONSE. If the input undervoltage fault retry is enabled, the module will shut down immediately once the input voltage falls below  $V_{UVLO}$  and then continuously checks the input voltage after a retry delay time, which can be configured from 35ms to 280ms. If the input voltage rises above the input undervoltage warning level, the module will restart. The input undervoltage warning is  $1.05 \times V_{UVLO}$  by default and can be programmed by the PMBus command VIN\_UV\_WARN\_LIMIT.

Table 7. SMBus Address and UVLO Resistor Setting

| PMBus Address | UVLO (V) | R (kΩ) |
|---------------|----------|--------|
| 26h           | 4.5      | LOW    |
| 28h           | 4.5      | OPEN   |
| 19h           | 10.8     | 10     |
| 1Ah           | 4.5      | 11     |
| 1Bh           | 10.8     | 12.1   |
| 1Ch           | 4.5      | 13.3   |
| 1Dh           | 10.8     | 14.7   |
| 1Eh           | 4.5      | 16.2   |
| 1Fh           | 10.8     | 17.8   |
| 20h           | 4.5      | 19.6   |
| 21h           | 10.8     | 21.5   |
| 22h           | 4.5      | 23.7   |
| 23h           | 10.8     | 26.1   |
| 24h           | 4.5      | 28.7   |
| 25h           | 10.8     | 31.6   |
| 26h           | 4.5      | 34.8   |
| 27h           | 10.8     | 38.3   |
| 28h           | 4.5      | 42.2   |
| 29h           | 10.8     | 46.4   |

**Table 7. SMBus Address and UVLO Resistor Setting (Continued)**

| PMBus Address | UVLO (V) | R (kΩ) |
|---------------|----------|--------|
| 2Ah           | 4.5      | 51.1   |
| 2Bh           | 10.8     | 56.2   |
| 2Ch           | 4.5      | 61.9   |
| 2Dh           | 10.8     | 68.1   |
| 2Eh           | 4.5      | 75     |
| 2Fh           | 10.8     | 82.5   |
| 30h           | 4.5      | 90.9   |
| 31h           | 10.8     | 100    |
| 32h           | 4.5      | 110    |
| 33h           | 10.8     | 121    |

#### 4.10 Output Overvoltage Protection

The ISL8274M offers an internal output overvoltage protection circuit that can be used to protect sensitive load circuitry from being subjected to a voltage higher than its prescribed limits. A hardware comparator compares the actual output voltage (seen at pins VSEN1/2P, VSEN1/2N) to a threshold set to 15% higher than the target output voltage (default setting). The fault threshold can be programmed to a desired level by the PMBus command VOUT\_OV\_FAULT\_LIMIT. If the VSEN1/2P, VSEN1/2N voltage exceeds this threshold, the module will initiate an immediate shutdown without retry. Continuous retry can be enabled using the PMBus command VOUT\_OV\_FAULT\_RESPONSE. The retry delay time can be configured from 35ms to 280ms.

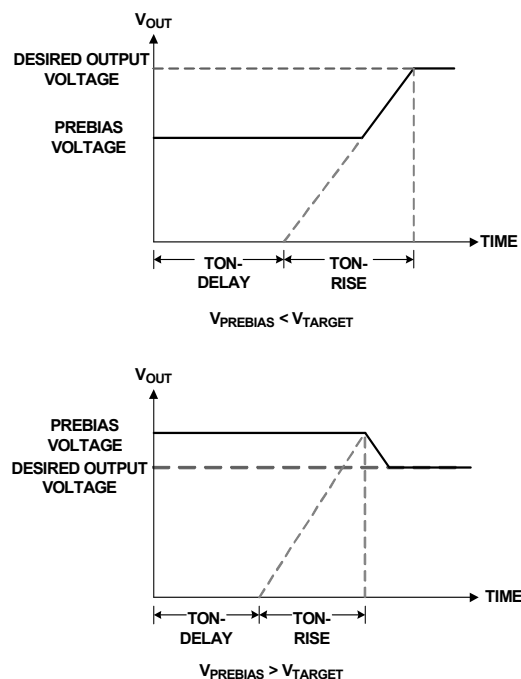
Internal to the module, two 100Ω resistors are populated from V<sub>OUT</sub> to VSEN1/2P and SGND to VSEN1/2N to protect the module from overvoltage conditions in case of open at the voltage sensing pins and differential remote sense traces due to assembly error. As long as differential remote sense traces have low resistance, V<sub>OUT</sub> regulation accuracy is not compromised.

#### 4.11 Output Prebias Protection

An output prebias condition exists when an externally applied voltage is present on a power supply's output before the power supply's control IC is enabled. Certain applications require that the converter not be allowed to sink current during start-up if a prebias condition exists at the output. The ISL8274M provides prebias protection by sampling the output voltage before initiating an output ramp.

If a prebias voltage lower than the target voltage exists after the preconfigured delay period has expired, the target voltage is set to match the existing prebias voltage and both drivers are enabled. The output voltage is then ramped to the final regulation value at the preconfigured ramp rate.

The actual time the output takes to ramp from the prebias voltage to the target voltage varies, depending on the prebias voltage. However, the total time elapsed from when the delay period expires to when the output reaches its target value will match the preconfigured ramp time (see [Figure 31 on page 30](#)).



**Figure 31. Output Responses to Prebias Voltages**

If a prebias voltage is higher than the target voltage after the preconfigured delay period has expired, the target voltage is set to match the existing prebias voltage. Thus, both drivers are enabled with a PWM duty cycle that would ideally create the prebias voltage.

Once the preconfigured soft-start ramp period has expired, the PG pin is asserted (assuming the prebias voltage is not higher than the overvoltage limit). The PWM then adjusts its duty cycle to match the original target voltage and the output ramps down to the preconfigured output voltage.

If a prebias voltage is higher than the overvoltage limit, the device does not initiate a turn-on sequence and declares an overvoltage fault condition. The device then responds based on the output overvoltage fault response setting programmed by the PMBus command `VOUT_OV_FAULT_RESPONSE`.

## 4.12 Thermal Overload Protection

The ISL8274M includes a thermal sensor that continuously measures the internal temperature of the module and shuts down the controller when the temperature exceeds the preset limit. The factory default temperature limit is set to  $+115^{\circ}\text{C}$ , and can be changed using the PMBus command `OT_FAULT_LIMIT`. Note that the temperature reading from the PMBus command is the temperature of the internal controller, which is lower than the junction temperature of the module.

The default response from an over-temperature fault is an immediate shutdown without retry. Retry settings can be programmed using the PMBus command `OT_FAULT_RESPONSE`. Hysteresis is implemented with the over-temperature fault retry. If a retry is enabled, the module will shut down immediately upon an over-temperature fault event and then continuously check the temperature after a retry delay time, which can be configured from 35ms to 280ms. If the temperature falls below the over-temperature warning level, the module will restart. The over-temperature warning is  $+105^{\circ}\text{C}$  by default and programmable using the PMBus command `OT_WARN_LIMIT`.

### 4.13 Digital-DC Bus

The Digital-DC Communications (DDC) bus is used to communicate between the Renesas digital power modules and digital controllers. The DDC bus provides the communication channel between devices for features such as current sharing, sequencing and fault spreading. The DDC pin on all Digital-DC devices in an application should be connected together. A pull-up resistor is required on the DDC bus in order to guarantee the rise time as shown in (EQ. 1):

$$(EQ. 1) \quad \text{Rise Time} = R_{PU} \cdot C_{LOAD} < 1\mu s$$

where  $R_{PU}$  is the DDC bus pull-up resistance and  $C_{LOAD}$  is the bus loading. The pull-up resistor may be tied to an external 3.3V or 5V supply as long as this voltage is present before or during the device power-up. In principle, each device connected to the DDC bus represents approximately 10pF of capacitive loading, and each inch of FR4 PCB trace introduces approximately 2pF. The ideal design uses a central pull-up resistor that is well-matched to the total load capacitance.

### 4.14 Phase Spreading

When multiple point-of-load converters share a common DC input supply, it is desirable to adjust the clock phase offset of each device, such that not all devices start to switch simultaneously. Setting each converter to start its switching cycle at a different point in time can dramatically reduce input capacitance requirements and efficiency losses. Because the peak current drawn from the input supply is effectively spread out over a period of time, the peak current drawn at any given moment is reduced, and the power losses proportional to the  $I_{RMS}^2$  are reduced dramatically.

To enable phase spreading, all converters must be synchronized to the same switching clock. The phase offset of each device may also be set to any value between 0° and 360° in 22.5° increments with the PMBus command INTERLEAVE. The internal two phases of the module always maintain a phase difference of 180°.

### 4.15 Fault Spreading

Digital-DC modules and devices can be configured to broadcast a fault event over the DDC bus to the other devices in the group using the PMBus command DDC\_GROUP. When a nondestructive fault occurs, the device shuts down and broadcasts the fault event over the DDC bus. The other devices on the DDC bus shut down simultaneously, if configured to do so.

Note that fault retry is not supported in multiple modules with fault spreading enabled.

### 4.16 Output Sequencing

A group of Digital-DC modules or devices can be configured to power up in a predetermined sequence. This feature is especially useful when powering advanced processors (FPGAs and ASICs) that require one supply to reach its operating voltage before another supply reaching it in order to avoid latch-up. Multidevice sequencing can be achieved by configuring each device with the PMBus command SEQUENCE. Multiple device sequencing is configured by issuing PMBus commands to assign the preceding device in the sequencing chain as well as the device that follows the sequence.

The Enable pins of all devices in a sequencing group must be tied together and driven high to initiate a sequenced turn-on of the group. The enable must be driven low to initiate a sequenced turnoff of the group. It is recommended to enable fault spreading with the PMBus command DDC\_GROUP within a sequencing group.

### 4.17 Monitoring Using SMBus

The ISL8274M can monitor a wide variety of different system parameters using the PMBus commands:

- READ\_VIN
- READ\_VOUT
- READ\_IOUT
- READ\_INTERNAL\_TEMP
- READ\_DUTY\_CYCLE
- READ\_FREQUENCY
- READ\_VMON

### 4.18 Snapshot Parameter Capture

The ISL8274M offers a special feature to capture parametric data and fault status following a fault. A detailed description is provided in the [“PMBus Commands Description” on page 42](#) under PMBus the commands SNAPSHOT and SNAPSHOT\_CONTROL.

### 4.19 Nonvolatile Memory

The ISL8274M stores user configurations in internal nonvolatile memory. Integrated security measures ensure that the user can only restore the module to a level that has been made available to them. During the initialization process, the ISL8274M checks for stored values contained in its internal nonvolatile memory.

Modules are shipped with factory defaults configuration and most settings can be overwritten by PMBus commands and can be stored in nonvolatile memory by the PMBus command STORE\_USER\_ALL.



## 5. Layout Guide

To achieve stable operation, low losses, and good thermal performance, some layout considerations are necessary ([Figure 32](#)). Refer to the ISL8274MEVAL1Z layout design.

- Establish separate SGND plane and PGND planes, then connect SGND to PGND plane on a middle layer and underneath PAD6 with a single point connection. For SGND and PGND pin connections, such as small pins H16, J16, M5 and M17..., use multiple vias for each pin to connect to inner SGND or PGND layers.
- Place enough ceramic capacitors between VIN and PGND, VOUT and PGND and bypass capacitors between VDD, VDRV and the ground plane, as close to the module as possible to minimize high frequency noise. It is very critical to place the output ceramic capacitors close to the VOUT pads and in the direction of the load current path in order to create a low impedance path for the high frequency inductor ripple current.
- Use large copper areas for power paths (VIN, PGND, VOUT) to minimize conduction loss and thermal stress. Also, use multiple vias to connect the power planes in different layers. It is recommended to enlarge PAD11 and PAD9 to place more vias on them. The ceramic capacitors CIN can be placed on the bottom layer under these two pads.
- Connect remote sensing traces to the regulation point to achieve a tight output voltage regulation and place the two traces in parallel. Route a trace from VSEN1/2N and VSEN1/2P to the point of load where the tight output voltage is desired. Avoid routing any sensitive signal traces, such as the VSENN, VSENP sensing lines near the SW pins.
- PAD14 and 16 (SW1 and SW2) are noisy pads, but they are beneficial for thermal dissipation. If the noise issue is critical for the applications, it is recommended to use only the top layer for the SW pads. For better thermal performance, use multiple vias on these pads to connect into the SW inner and bottom layers. However, use caution when placing a limited area of SW planes in any layer. The SW planes should avoid the sensing signals and should be surrounded by the PGND layer to avoid noise coupling.
- For pins SWD1 (L3) and SWD2 (P10), it is recommended to connect to the related SW1 and SW2 pads with short loop traces. The trace width should be more than 20 mils.

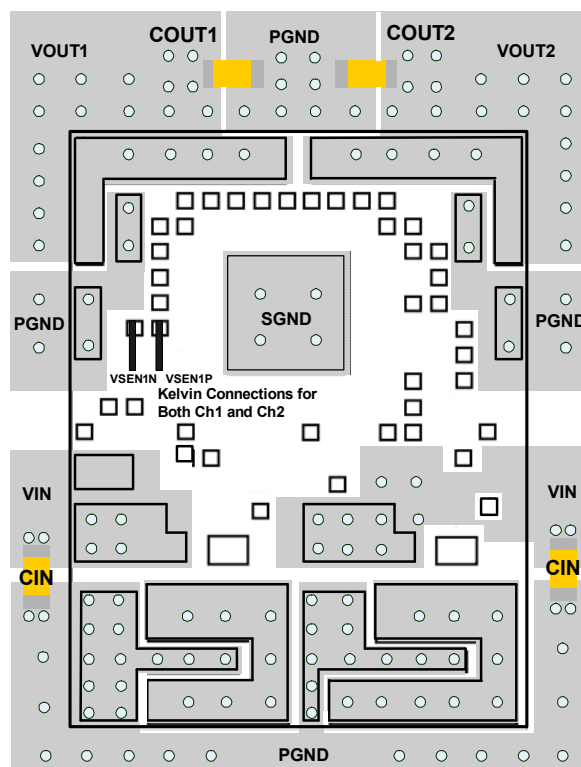


Figure 32. Recommended Layout

## 5.1 Thermal Considerations

Experimental power loss curves along with  $\theta_{JA}$  from thermal modeling analysis can be used to evaluate the thermal consideration for the module. The derating curves are derived from the maximum power allowed while maintaining the temperature below the maximum junction temperature of +125°C. The derating curves are derived based on tests of the ISL8274MEVAL1Z evaluation board, which is an 8-layer board 4.5x4inch in size with 2oz Cu on the top and bottom layers, 1oz Cu on the inner layers, and multiple via interconnects. In the actual application, other heat sources and design margins should be considered.

## 5.2 Package Description

The structure of the ISL8274M belongs to the High Density Array (HDA) no-lead package. This kind of package has advantages, such as good thermal and electrical conductivity, low weight, and small size. The HDA package is applicable for surface mounting technology and is being more readily used in the industry. The ISL8274M contains several types of devices, including resistors, capacitors, inductors, and control ICs. The ISL8274M is a copper leadframe based package with exposed copper thermal pads, which have good electrical and thermal conductivity. The copper leadframe and multicomponent assembly is overmolded with a polymer mold compound to protect these devices.

The package outline and typical PCB layout pattern design and typical stencil pattern design are shown on [pages 73 through page 79](#). The module has a small size of 18mmx 23mmx 7.5mm.

## 5.3 PCB Layout Pattern Design

The bottom of ISL8274M is a leadframe footprint, which is attached to the PCB by the surface mounting process. The PCB layout pattern is shown on [pages 77 through 79](#). The PCB layout pattern is an array of solder mask defined PCB lands which align with the perimeters of the HDA exposed pads and I/O termination dimensions. The thermal lands on the PCB layout also feature an array of solder mask defined lands and should match 1:1 with the package exposed die pads.

## 5.4 Thermal Vias

A grid of 1.0mm to 1.2mm pitch thermal vias, which drops down and connects to buried copper plane(s), should be placed under the thermal land. The vias should be about 0.3mm to 0.33mm in diameter with the barrel plated to about 1.0 oz. of copper. Although adding more vias (by decreasing via pitch) will improve the thermal performance, diminishing returns will be seen as the number of vias is increased. Simply use as many vias as practical for the thermal land size and your board design rules will allow. All vias should be capped and filled to avoid scavenging solder from the I/O solder joints and creating voids.

## 5.5 Stencil Pattern Design

Reflowed solder joints on the perimeter I/O lands should have about a 50μm to 75μm (2 mil to 3 mil) standoff height. The solder paste stencil design is the first step in developing optimized, reliable solder joins. Stencil aperture size to solder mask defined PCB land size ratio should typically be 1:1. The aperture width may be reduced slightly to help prevent solder bridging between adjacent I/O lands. To reduce solder paste volume on the larger thermal lands, it is recommended that an array of smaller apertures be used instead of one large aperture. It is recommended that the stencil printing area cover 50% to 80% of the PCB layout pattern. A typical solder stencil pattern is shown on [pages 71 through 77](#). The gap width between pads is 0.6mm. The user should consider the symmetry of the whole stencil pattern when designing its pads. A laser cut, stainless steel stencil with electropolished trapezoidal walls is recommended. Electropolishing “smooths” the aperture walls resulting in reduced surface friction and better paste release, which reduces voids. Using a Trapezoidal Section Aperture (TSA) also promotes paste release and forms a “brick like” paste deposit that assists in firm component placement. A 0.1mm to 0.15mm stencil thickness is recommended for this large pitch (1.3mm) HDA.

## 5.6 Reflow Parameters

Due to the low mount height of the HDA, “No-Clean” Type 3 solder paste per ANSI/J-STD-005 is recommended. A nitrogen purge is also recommended during reflow. A system board reflow profile depends on the thermal mass of the entire populated board, so it is not practical to define a specific soldering profile just for the HDA. The profile given in [Figure 33](#) is provided as a guideline, which can be customized for varying manufacturing practices and applications.

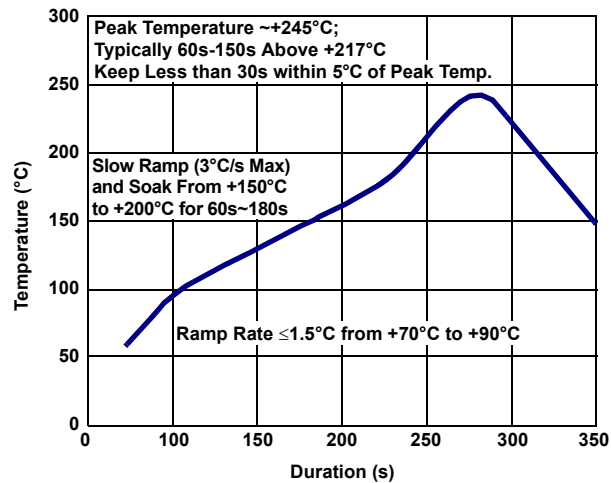


Figure 33. Typical Reflow Profile

## 6. PMBus Command Summary

| Command Code | Command Name         | Description                                                                  | Type      | Data Format | Default Value        | Default Setting                          | Page                    |
|--------------|----------------------|------------------------------------------------------------------------------|-----------|-------------|----------------------|------------------------------------------|-------------------------|
| 00h          | PAGE                 | Selects Controller 0, 1, or both.                                            | R/W Byte  | BIT         | 00h                  | Channel 1                                | <a href="#">page 42</a> |
| 01h          | OPERATION            | Sets Enable, Disable, and $V_{OUT}$ Margin modes.                            | R/W Byte  | BIT         |                      |                                          | <a href="#">page 42</a> |
| 02h          | ON_OFF_CONFIG        | Configures the EN pin and PMBus commands to turn the unit ON/OFF.            | R/W Byte  | BIT         | 17h                  | Hardware Pin Enable, immediate off       | <a href="#">page 42</a> |
| 03h          | CLEAR_FAULTS         | Clears fault indications.                                                    | SEND Byte |             |                      |                                          | <a href="#">page 43</a> |
| 15h          | STORE_USER_ALL       | Stores all PMBus values written since last restore at user level.            | SEND Byte |             |                      |                                          | <a href="#">page 43</a> |
| 16h          | RESTORE_USER_ALL     | Restores PMBus settings that were stored using STORE_USER_ALL.               | SEND Byte |             |                      |                                          | <a href="#">page 43</a> |
| 20h          | VOUT_MODE            | Preset to defined data format of $V_{OUT}$ commands.                         | READ Byte | BIT         | 13h                  | Linear Mode, Exponent = -13              | <a href="#">page 43</a> |
| 21h          | VOUT_COMMAND         | Sets the nominal value of the output voltage.                                | R/W Word  | L16u        |                      | Pin-strap                                | <a href="#">page 44</a> |
| 23h          | VOUT_CAL_OFFSET      | Applies a fixed offset voltage to the VOUT_COMMAND.                          | R/W Word  | L16s        | 0000h                | 0V                                       | <a href="#">page 44</a> |
| 24h          | VOUT_MAX             | Sets the maximum possible value of $V_{OUT}$ . 110% of pin-strap $V_{OUT}$ . | R/W Word  | L16u        |                      | 1.1* $V_{OUT}$ Pin-strap                 | <a href="#">page 44</a> |
| 25h          | VOUT_MARGIN_HIGH     | Sets the value of the $V_{OUT}$ during a margin high.                        | R/W Word  | L16u        |                      | 1.05* $V_{OUT}$ Pin-strap                | <a href="#">page 44</a> |
| 26h          | VOUT_MARGIN_LOW      | Sets the value of the $V_{OUT}$ during a margin low.                         | R/W Word  | L16u        |                      | 0.95* $V_{OUT}$ Pin-strap                | <a href="#">page 45</a> |
| 27h          | VOUT_TRANSITION_RATE | Sets the transition rate during margin or other change of $V_{OUT}$ .        | R/W Word  | L11         | BA00h                | 1V/ms                                    | <a href="#">page 45</a> |
| 28h          | VOUT_DROOP           | Sets the loadline (V/I Slope) resistance for the rail.                       | R/W Word  | L11         | 0000h                | 0mV/A                                    | <a href="#">page 45</a> |
| 33h          | FREQUENCY_SWITCH     | Sets the switching frequency.                                                | R/W Word  | L11         |                      | Pin-strap                                | <a href="#">page 45</a> |
| 37h          | INTERLEAVE           | Configures a phase offset between devices sharing a SYNC clock.              | R/W Word  | BIT         | 0021h(Ch1)/0022(Ch2) | 180° phase shift between Ch1/Ch2         | <a href="#">page 46</a> |
| 38h          | IOUT_CAL_GAIN        | Sense resistance for inductor DCR current sensing.                           | R/W Word  | L11         | B2C3(Ch1)/B2D7(Ch2)  | 0.69m $\Omega$ (Ch1)/0.7m $\Omega$ (Ch2) | <a href="#">page 46</a> |
| 39h          | IOUT_CAL_OFFSET      | Sets the current-sense offset.                                               | R/W Word  | L11         | B529(Ch1)/BDDC(Ch2)  | -0.71A(Ch1)/-1.07A(Ch2)                  | <a href="#">page 46</a> |

| Command Code | Command Name           | Description                                               | Type     | Data Format | Default Value | Default Setting                             | Page                    |
|--------------|------------------------|-----------------------------------------------------------|----------|-------------|---------------|---------------------------------------------|-------------------------|
| 40h          | VOUT_OV_FAULT_LIMIT    | Sets the $V_{OUT}$ overvoltage fault threshold.           | R/W Word | L16u        |               | $1.15 \times V_{OUT}$ Pin-strap             | <a href="#">page 46</a> |
| 41h          | VOUT_OV_FAULT_RESPONSE | Configures the $V_{OUT}$ overvoltage fault response.      | R/W Byte | BIT         | 80h           | Disable and No Retry                        | <a href="#">page 47</a> |
| 42h          | VOUT_OV_WARN_LIMIT     | Sets the $V_{OUT}$ overvoltage warn threshold.            | R/W Word | L16u        |               | $1.10 \times V_{OUT}$ Pin-strap             | <a href="#">page 47</a> |
| 43h          | VOUT_UV_WARN_LIMIT     | Sets the $V_{OUT}$ undervoltage warn threshold.           | R/W Word | L16u        |               | $0.9 \times V_{OUT}$ Pin-strap              | <a href="#">page 47</a> |
| 44h          | VOUT_UV_FAULT_LIMIT    | Sets the $V_{OUT}$ undervoltage fault threshold.          | R/W Word | L16u        |               | $0.85 \times V_{OUT}$ Pin-strap             | <a href="#">page 48</a> |
| 45h          | VOUT_UV_FAULT_RESPONSE | Configures the $V_{OUT}$ undervoltage fault response.     | R/W Byte | BIT         | 80h           | Disable and No Retry                        | <a href="#">page 48</a> |
| 46h          | IOUT_OC_FAULT_LIMIT    | Sets the $I_{OUT}$ peak overcurrent fault threshold.      | R/W Word | L11         | E320h         | 50A                                         | <a href="#">page 48</a> |
| 4Ah          | IOUT_OC_WARN_LIMIT     | Sets the $I_{OUT}$ average overcurrent warning threshold. | R/W Word | L11         |               | $0.9 \times I_{OUT\_AVG\_OC\_FAULT\_LIMIT}$ | <a href="#">page 49</a> |
| 4Bh          | IOUT_UC_FAULT_LIMIT    | Sets the $I_{OUT}$ valley undercurrent fault threshold.   | R/W Word | L11         | E4E0h         | -50A                                        | <a href="#">page 49</a> |
| 4Fh          | OT_FAULT_LIMIT         | Sets the over-temperature fault threshold.                | R/W Word | L11         | EB98h         | +115°C                                      | <a href="#">page 49</a> |
| 50h          | OT_FAULT_RESPONSE      | Configures the over-temperature fault response.           | R/W Byte | BIT         | 80h           | Disable and No Retry                        | <a href="#">page 50</a> |
| 51h          | OT_WARN_LIMIT          | Sets the over-temperature warning limit.                  | R/W Word | L11         | EB48h         | +105°C                                      | <a href="#">page 50</a> |
| 52h          | UT_WARN_LIMIT          | Sets the under-temperature warning limit.                 | R/W WORD | L11         | DC40h         | -30°C                                       | <a href="#">page 50</a> |
| 53h          | UT_FAULT_LIMIT         | Sets the under-temperature fault threshold.               | R/W Word | L11         | E530h         | -45°C                                       | <a href="#">page 51</a> |
| 54h          | UT_FAULT_RESPONSE      | Configures the under-temperature fault response.          | R/W Byte | BIT         | 80h           | Disable and No Retry                        | <a href="#">page 51</a> |
| 55h          | VIN_OV_FAULT_LIMIT     | Sets the $V_{IN}$ overvoltage fault threshold.            | R/W Word | L11         | D3A0          | 14.5V                                       | <a href="#">page 51</a> |
| 56h          | VIN_OV_FAULT_RESPONSE  | Configures the $V_{IN}$ overvoltage fault response.       | R/W Byte | BIT         | 80h           | Disable and No Retry                        | <a href="#">page 52</a> |
| 57h          | VIN_OV_WARN_LIMIT      | Sets the input overvoltage warning limit.                 | R/W Word | L11         | D353h         | 13.3V                                       | <a href="#">page 52</a> |
| 58h          | VIN_UV_WARN_LIMIT      | Sets the input undervoltage warning limit.                | R/W Word | L11         |               | $1.03 \times V_{IN}$ UV Fault Limit         | <a href="#">page 52</a> |

| Command Code | Command Name          | Description                                                       | Type      | Data Format | Default Value | Default Setting                | Page                    |
|--------------|-----------------------|-------------------------------------------------------------------|-----------|-------------|---------------|--------------------------------|-------------------------|
| 59h          | VIN_UV_FAULT_LIMIT    | Sets the $V_{IN}$ undervoltage fault threshold.                   | R/W Word  | L11         |               | Pin-strap                      | <a href="#">page 53</a> |
| 5Ah          | VIN_UV_FAULT_RESPONSE | Configures the $V_{IN}$ undervoltage fault response.              | R/W Byte  | BIT         | 80h           | Disable and No Retry           | <a href="#">page 53</a> |
| 5Eh          | POWER_GOOD_ON         | Sets the voltage threshold for power-good indication.             | R/W Word  | L16u        |               | $0.9 \times V_{OUT}$ Pin-strap | <a href="#">page 53</a> |
| 60h          | TON_DELAY             | Sets the delay time from ENABLE to start of $V_{OUT}$ rise.       | R/W Word  | L11         |               | Pin-strap                      | <a href="#">page 54</a> |
| 61h          | TON_RISE              | Sets the rise time of $V_{OUT}$ after ENABLE and TON_DELAY.       | R/W Word  | L11         |               | Pin-strap                      | <a href="#">page 54</a> |
| 64h          | TOFF_DELAY            | Sets the delay time from DISABLE to start of $V_{OUT}$ fall.      | R/W Word  | L11         |               | Pin-strap                      | <a href="#">page 54</a> |
| 65h          | TOFF_FALL             | Sets the fall time for $V_{OUT}$ after DISABLE and TOFF_DELAY.    | R/W Word  | L11         |               | Pin-strap                      | <a href="#">page 54</a> |
| 78h          | STATUS_BYTE           | Returns an abbreviated status for fast reads.                     | Read Byte | BIT         | 00h           | No Faults                      | <a href="#">page 55</a> |
| 79h          | STATUS_WORD           | Returns information with a summary of the unit's fault condition. | Read Word | BIT         | 0000h         | No Faults                      | <a href="#">page 56</a> |
| 7Ah          | STATUS_VOUT           | Returns the $V_{OUT}$ specific status.                            | Read Byte | BIT         | 00h           | No Faults                      | <a href="#">page 56</a> |
| 7Bh          | STATUS_IOUT           | Returns the $I_{OUT}$ specific status.                            | Read Byte | BIT         | 00h           | No Faults                      | <a href="#">page 57</a> |
| 7Ch          | STATUS_INPUT          | Returns specific status specific to the input.                    | Read Byte | BIT         | 00h           | No Faults                      | <a href="#">page 57</a> |
| 7Dh          | STATUS_TEMP           | Returns the temperature specific status.                          | Read Byte | BIT         | 00h           | No Faults                      | <a href="#">page 57</a> |
| 7Eh          | STATUS_CML            | Returns the communication, logic and memory specific status.      | Read Byte | BIT         | 00h           | No Faults                      | <a href="#">page 58</a> |
| 80h          | STATUS_MFR_SPECIFIC   | Returns the VMON and external sync clock specific status.         | Read Byte | BIT         | 00h           | No Faults                      | <a href="#">page 58</a> |
| 88h          | READ_VIN              | Returns the input voltage reading.                                | Read Word | L11         |               |                                | <a href="#">page 58</a> |
| 8Bh          | READ_VOUT             | Returns the output voltage reading.                               | Read Word | L16u        |               |                                | <a href="#">page 59</a> |
| 8Ch          | READ_IOUT             | Returns the output current reading.                               | Read Word | L11         |               |                                | <a href="#">page 59</a> |
| 8Dh          | READ_INTERNAL_TEMP    | Returns the temperature reading internal to the device.           | Read Word | L11         |               |                                | <a href="#">page 59</a> |
| 94h          | READ_DUTY_CYCLE       | Returns the duty cycle reading during the ENABLE state.           | Read Word | L11         |               |                                | <a href="#">page 59</a> |

| Command Code | Command Name               | Description                                                               | Type       | Data Format | Default Value | Default Setting                                                                 | Page                    |
|--------------|----------------------------|---------------------------------------------------------------------------|------------|-------------|---------------|---------------------------------------------------------------------------------|-------------------------|
| 95h          | READ_FREQUENCY             | Returns the measured operating switch frequency.                          | Read Word  | L11         |               |                                                                                 | <a href="#">page 59</a> |
| 99h          | MFR_ID                     | Sets a user defined identification.                                       | R/W Block  | ASC         |               | Null                                                                            | <a href="#">page 60</a> |
| 9Ah          | MFR_MODEL                  | Sets a user defined model.                                                | R/W Block  | ASC         |               | Null                                                                            | <a href="#">page 60</a> |
| 9Bh          | MFR_REVISION               | Sets a user defined revision.                                             | R/W Block  | ASC         |               | Null                                                                            | <a href="#">page 60</a> |
| 9Ch          | MFR_LOCATION               | Sets a user defined location identifier.                                  | R/W Block  | ASC         |               | Null                                                                            | <a href="#">page 60</a> |
| 9Dh          | MFR_DATE                   | Sets a user defined date.                                                 | R/W Block  | ASC         |               | Null                                                                            | <a href="#">page 61</a> |
| 9Eh          | MFR_SERIAL                 | Sets a user defined serialized identifier.                                | R/W Block  | ASC         |               | Null                                                                            | <a href="#">page 61</a> |
| A8h          | LEGACY_FAULT_GROUP         | Sets rail IDs of legacy devices for fault spreading                       | R/W Block  | BIT         | 00000000h     | No rail ID specified                                                            | <a href="#">page 61</a> |
| B0h          | USER_DATA_00               | Sets a user defined data.                                                 | R/W Block  | ASC         |               | Null                                                                            | <a href="#">page 62</a> |
| D0h          | ISENSE_CONFIG              | Configures ISENSE related features.                                       | R/W Byte   | BIT         | 06h           | 256ns Blanking Time, High Range                                                 | <a href="#">page 62</a> |
| D1h          | USER_CONFIG                | Configures several user-level features.                                   | R/W Byte   | BIT         | 84h           | Minimum duty control, PG open drain                                             | <a href="#">page 63</a> |
| D3h          | DDC_CONFIG                 | Configures the DDC bus.                                                   | R/W Word   | BIT         |               | Pin-strap (Rail ID set based on PMBus address. Phase ID = 0; Phases in Rail = 1 | <a href="#">page 63</a> |
| D4h          | POWER_GOOD_DELAY           | Sets the delay between $V_{OUT} > PG$ threshold and asserting the PG pin. | R/W Word   | L11         | C300h         | 3ms                                                                             | <a href="#">page 64</a> |
| DFh          | ASCR_CONFIG                | Configures ASCR control loop.                                             | R/W Block  | CUS         |               | Pin-strap                                                                       | <a href="#">page 64</a> |
| E0h          | SEQUENCE                   | Identifies the Rail DDC ID to perform multi-rail sequencing.              | R/W Word   | BIT         | 0000h         | Prequel and Sequel Disabled                                                     | <a href="#">page 65</a> |
| E1h          | TRACK_CONFIG               | Configures voltage tracking modes                                         | R/W Byte   | BIT         |               | Pin-strap setting                                                               | <a href="#">page 66</a> |
| E2h          | DDC_GROUP                  | Sets rail DDC IDs to obey faults and margining spreading information.     | R/W Block  | BIT         |               | Ignore Broadcast VOUT_COMMAND, OPERATION                                        | <a href="#">page 66</a> |
| E4h          | DEVICE_ID                  | Returns the 16-byte (character) device identifier string.                 | Read Block | ASC         |               | Reads Device Version                                                            | <a href="#">page 67</a> |
| E5h          | MFR_IOUT_OC_FAULT_RESPONSE | Configures the $I_{OUT}$ overcurrent fault response.                      | R/W Byte   | BIT         | 80h           | Disable and No Retry                                                            | <a href="#">page 67</a> |
| E6h          | MFR_IOUT_UC_FAULT_RESPONSE | Configures the $I_{OUT}$ undercurrent fault response.                     | R/W Byte   | BIT         | 80h           | Disable and No Retry                                                            | <a href="#">page 67</a> |
| E7h          | IOUT_AVG_OC_FAULT_LIMIT    | Sets the $I_{OUT}$ average overcurrent fault threshold.                   | R/W        | L11         |               | Set by SYNC/OC pin-strap                                                        | <a href="#">page 68</a> |

| Command Code | Command Name            | Description                                                     | Type          | Data Format | Default Value | Default Setting                   | Page                    |
|--------------|-------------------------|-----------------------------------------------------------------|---------------|-------------|---------------|-----------------------------------|-------------------------|
| E8h          | IOUT_AVG_UC_FAULT_LIMIT | Sets the I <sub>OUT</sub> average undercurrent fault threshold. | R/W           | L11         | DC40h         | -30A                              | <a href="#">page 68</a> |
| E9h          | SYNC_CONFIG             | Configures the SYNC pin.                                        | R/W<br>Byte   | BIT         | 00h           | Pin-strap (set based on SYNC/OCP) | <a href="#">page 69</a> |
| EAh          | SNAPSHOT                | Returns 32-byte read-back of parametric and status values.      | Read<br>Block | BIT         |               |                                   | <a href="#">page 69</a> |
| EBh          | BLANK_PARAMS            | Returns recently changed parameter values.                      | Read<br>Block | BIT         | FF...FFh      |                                   | <a href="#">page 70</a> |
| F3h          | SNAPSHOT_CONTROL        | Snapshot feature control command.                               | R/W<br>Byte   | BIT         |               |                                   | <a href="#">page 70</a> |
| F4h          | RESTORE_FACTORY         | Restores device to the factory default values.                  | Send<br>Byte  |             |               |                                   | <a href="#">page 70</a> |
| F5h          | MFR_VMON_OV_FAULT_LIMIT | Returns the VMON overvoltage threshold.                         | Read<br>Word  | L11         | CB00h         | 6V                                | <a href="#">page 70</a> |
| F6h          | MFR_VMON_UV_FAULT_LIMIT | Returns the VMON undervoltage threshold.                        | Read<br>Word  | L11         | CA00h         | 4V                                | <a href="#">page 71</a> |
| F7h          | MFR_READ_VMON           | Returns the VMON voltage reading.                               | Read<br>Word  | L11         |               |                                   | <a href="#">page 71</a> |
| F8h          | VMON_OV_FAULT_RESPONSE  | Returns the VMON overvoltage response.                          | Read<br>Byte  | BIT         | 80h           | Disable and No Retry              | <a href="#">page 71</a> |
| F9h          | VMON_UV_FAULT_RESPONSE  | Returns the VMON undervoltage response.                         | Read<br>Byte  | BIT         | 80h           | Disable and No Retry              | <a href="#">page 71</a> |



## 6.1 PMBus Data Formats

### Linear-11 (L11)

L11 data format uses 5-bit two's complement exponent (N) and 11-bit two's complement mantissa (Y) to represent real world decimal value (X).



Relation between real world decimal value (X), N, and Y is:  $X = Y \cdot 2^N$

### Linear-16 Unsigned (L16u)

L16u data format uses a fixed exponent (hard-coded to  $N = -13$ ) and a 16-bit unsigned integer mantissa (Y) to represent real world decimal value (X). Relation between real world decimal value (X), N and Y is:  $X = Y \cdot 2^{-13}$

### Linear-16 Signed (L16s)

L16s data format uses a fixed exponent (hard-coded to  $N = -13$ ) and a 16-bit two's complement mantissa (Y) to represent real world decimal value (X).

Relation between real world decimal value (X), N and Y is:  $X = Y \cdot 2^{-13}$

### Bit Field (BIT)

An explanation of the Bit Field for each command is provided in [“PMBus Commands Description” on page 41](#).

### Custom (CUS)

An explanation of the Custom data format for each command is provided in [“PMBus Commands Description” on page 41](#). A combination of Bit Field and integer is a common type of Custom data format.

### ASCII (ASC)

A variable length string of text characters uses ASCII data format.

## 6.2 PMBus Use Guidelines

The PMBus is a powerful tool that allows the user to optimize circuit performance by configuring devices for their application. When configuring a device in a circuit, the device should be disabled whenever most settings are changed with PMBus commands. Some exceptions to this recommendation are OPERATION, ON\_OFF\_CONFIG, CLEAR\_FAULTS, VOUT\_COMMAND, VOUT\_MARGIN\_HIGH, VOUT\_MARGIN\_LOW, and ASCCR\_CONFIG. While the device is enabled any command can be read. Many commands do not take effect until after the device has been re-enabled, hence the recommendation that commands that change device settings are written while the device is disabled.

When sending the STORE\_USER\_ALL and RESTORE\_USER\_ALL commands, it is recommended that no other commands are sent to the device for 100ms after sending STORE or RESTORE commands.

In addition, there should be a 2ms delay between repeated READ commands sent to the same device. When sending any other command, a 5ms delay is recommended between repeated commands sent to the same device.

## 6.3 Summary

All commands can be read at any time.

Always disable the device when writing commands that change device settings. Exceptions to this rule are commands intended to be written while the device is enabled, for example, VOUT\_MARGIN\_HIGH.

To be sure a change to a device setting has taken effect, write the STORE\_USER\_ALL command, then cycle input power and re-enable.

## 7. PMBus Commands Description

### PAGE(00h)

**Definition:** Select Channel 1, Channel 2 or both channels to receive commands. All commands following this command will be received and acted on by the selected channel or channels.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 00h (Page 0)

**Units:** N/A

| Bits 7:4 | Bits 3:0 | Page |
|----------|----------|------|
| 0000     | 0000     | 0    |
| 0000     | 0001     | 1    |
| 1111     | 1111     | Both |

### OPERATION (01h)

**Definition:** Sets Enable, Disable and  $V_{OUT}$  Margin settings.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:**

**Units:** N/A

| Settings | Actions                       |
|----------|-------------------------------|
| 00h      | Immediate off (no sequencing) |
| 40h      | Soft off (with sequencing)    |
| 80h      | On - Nominal                  |
| 90h      | On - Margin low               |
| A0h      | On - Margin high              |

### ON\_OFF\_CONFIG (02h)

**Definition:** Configures the interpretation and coordination of the OPERATION command and the ENABLE pin (EN).

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 17h (Device starts from ENABLE pin with soft-off)

**Units:** N/A

| Settings | Actions                                                  |
|----------|----------------------------------------------------------|
| 16h      | Device starts from ENABLE pin with soft off.             |
| 17h      | Device starts from ENABLE pin with immediate off.        |
| 1Ah      | Device starts from OPERATION command with soft off.      |
| 1Bh      | Device starts from OPERATION command with immediate off. |

**CLEAR\_FAULTS (03h)**

**Definition:** Clears all fault bits in all registers and releases the SALRT pin (if asserted) simultaneously. If a fault condition still exists, the bit will reassert immediately. This command will not restart a device if it has shut down, it will only clear the faults.

**Data Length in Bytes:** 0 Byte

**Data Format:** N/A

**Type:** Send byte

**Default Value:** N/A

**Units:** N/A

**Reference:** N/A

**STORE\_USER\_ALL (15h)**

**Definition:** Stores all PMBus settings from the operating memory to the nonvolatile USER store memory. To clear the USER store, perform a RESTORE\_FACTORY then STORE\_USER\_ALL. To add to the USER store, perform a RESTORE\_USER\_ALL, write commands to be added, then STORE\_USER\_ALL. This command can be used during device operation, but the device will be unresponsive for 20ms while storing values.

**Data Length in Bytes:** 0

**Data Format:** N/A

**Type:** Send byte

**Default Value:** N/A

**Units:** N/A

**RESTORE\_USER\_ALL (16h)**

**Definition:** Restores all PMBus settings from the USER store memory to the operating memory. Command performed at power-up. Security level is changed to Level 1 following this command. This command can be used during device operation, but the device will be unresponsive for 20ms while storing values.

**Data Length in Bytes:** 0

**Data Format:** N/A

**Type:** Send byte

**Default Value:** N/A

**Units:** N/A

**VOUT\_MODE (20h)**

**Definition:** Reports the  $V_{OUT}$  mode and provides the exponent used in calculating several  $V_{OUT}$  settings. Fixed with linear mode with default exponent (N) = -13

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** Read Only

**Default Value:** 13h (Linear Mode, N = -13)

**Units:** N/A

**VOUT\_COMMAND (21h)**

**Definition:** Sets or reports the target output voltage. This command cannot set a value higher than VOUT\_MAX.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** Pin-strap setting

**Units:** Volts

**Range:** 0V to VOUT\_MAX

**VOUT\_CAL\_OFFSET (23h)**

**Definition:** Applies a fixed offset voltage to the output voltage command value. This command is typically used by the user to calibrate a device in the application circuit.

**Data Length in Bytes:** 2

**Data Format:** L16s

**Type:** R/W

**Default Value:** 0000h

**Units:** Volts

**VOUT\_MAX (24h)**

**Definition:** Sets an upper limit on the output voltage the unit can command regardless of any other commands or combinations. The intent of this command is to provide a safeguard against a user accidentally setting the output voltage to a possibly destructive level rather than to be the primary output overprotection. Default value can be changed using PMBus.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** 1.10xVOUT\_COMMAND pin-strap setting

**Units:** Volts

**Range:** 0V to 5.5V

**VOUT\_MARGIN\_HIGH (25h)**

**Definition:** Sets the value of the V<sub>OUT</sub> during a margin high. This VOUT\_MARGIN\_HIGH command loads the unit with the voltage to which the output is to be changed when the OPERATION command is set to “Margin High”.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** 1.05 x VOUT\_COMMAND pin-strap setting

**Units:** V

**Range:** 0V to VOUT\_MAX

**VOUT\_MARGIN\_LOW (26h)**

**Definition:** Sets the value of the  $V_{OUT}$  during a margin low. This VOUT\_MARGIN\_LOW command loads the unit with the voltage to which the output is to be changed when the OPERATION command is set to “Margin Low”.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** 0.95 x VOUT\_COMMAND pin-strap setting

**Units:** V

**Range:** 0V to VOUT\_MAX

**VOUT\_TRANSITION\_RATE (27h)**

**Definition:** Sets the rate at which the output should change voltage when the device receives the VOUT\_COMMAND or an OPERATION command (Margin High, Margin Low) that causes the output voltage to change. The maximum possible positive value of the two data bytes indicates that the device should make the transition as quickly as possible.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** BA00h (1V/ms)

**Units:** V/ms

**Range:** 0.1V/ms to 4V/ms

**VOUT\_DROOP (28h)**

**Definition:** Sets the effective load line (V/I slope) for the rail in which the device is used. It is the rate, in mV/A, at which the output voltage decreases (or increases) with increasing (or decreasing) output current for use with adaptive voltage positioning schemes or multi-module current sharing. In current sharing configuration, VOUT\_DROOP set in each module stands for the droop seen by the load.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Pin-strap setting

**Units:** mV/A

**Range:** 0mV/A to 40mV/A

**FREQUENCY\_SWITCH (33h)**

**Definition:** Sets the switching frequency of the device. Initial default value is defined by a pin-strap and this value can be overridden by writing this command through the PMBus. If an external SYNC is utilized, this value should be set as close as possible to the external clock value. The output must be disabled when writing this command.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Pin-strap setting

**Units:** kHz

**Range:** 296kHz to 1066kHz

**INTERLEAVE (37h)**

**Definition:** Configures the phase offset of a device that is sharing a common SYNC clock with other devices. The phase offset of each device can be set to any value between 0° and 360° in 22.5° increments. The internal two phases of the module always maintain a phase difference of 180°.

**Data Length in Bytes:** 2

**Data Format:** BIT

**Type:** R/W

**Default Value:** 0021h (Page0), 0022h (Page1)

**Units:** N/A

| Bits | Purpose           | Value   | Description                                          |
|------|-------------------|---------|------------------------------------------------------|
| 15:4 | Reserved          | 0       | Reserved                                             |
| 3:0  | Position in Group | 0 to 15 | Sets position of the device's rail within the group. |

**IOUT\_CAL\_GAIN (38h)**

**Definition:** Sets the effective impedance across the current sense circuit for use in calculating output current at +25°C.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Ch1: B2C3(0.69mΩ); Ch2: B2D7(0.7mΩ)

**Units:** mΩ

**IOUT\_CAL\_OFFSET (39h)**

**Definition:** Nulls out any offsets in the output current sensing circuit for each phase, and compensates for delayed measurements of current ramp due to  $I_{SENSE}$  blanking time.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Ch1: B529(-0.71A); Ch2: BDDC(-1.07A)

**Units:** A

**VOUT\_OV\_FAULT\_LIMIT (40h)**

**Definition:** Sets the  $V_{OUT}$  overvoltage fault threshold.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** 1.15xVOUT\_COMMAND pin-strap setting

**Units:** V

**Range:** 0V to VOUT\_MAX

**VOUT\_OV\_FAULT\_RESPONSE (41h)**

**Definition:** Configures the  $V_{OUT}$  overvoltage fault response. Note that the device cannot be set to ignore this fault mode.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 80h (Disable and no retry)

**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1) * 35ms. Sets the time between retries in 35ms                                                                                                                                                           |

**VOUT\_OV\_WARN\_LIMIT (42h)**

**Definition:** Sets the  $V_{OUT}$  overvoltage warning threshold. The power-good signal is pulled low when the output voltage goes higher than this threshold.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** 1.10xVOUT\_COMMAND pin-strap setting

**Units:** V

**Range:** 0V to VOUT\_MAX

**VOUT\_UV\_WARN\_LIMIT (43h)**

**Definition:** Sets the  $V_{OUT}$  undervoltage warning threshold. The power-good signal is pulled low when the output voltage goes lower than this threshold.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** 0.90 x VOUT\_COMMAND pin-strap setting

**Units:** V

**Range:** 0V to VOUT\_MAX

**VOUT\_UV\_FAULT\_LIMIT (44h)**

**Definition:** Sets the  $V_{OUT}$  undervoltage fault threshold. This fault is masked during ramp or when disabled.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** R/W

**Default Value:** 0.85 x  $V_{OUT\_COMMAND}$  pin-strap setting

**Units:** V

**Range:** 0V to  $V_{OUT\_MAX}$

**VOUT\_UV\_FAULT\_RESPONSE (45h)**

**Definition:** Configures the  $V_{OUT}$  undervoltage fault response.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 80h (Disable, no retry)

**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1) * 35ms. Sets the time between retries in 35ms increments. Range is 35ms to 280ms.                                                                                                                       |

**IOUT\_OC\_FAULT\_LIMIT (46h)**

**Definition:** Sets the  $I_{OUT}$  peak overcurrent fault threshold. This limit is applied to current measurement samples taken after the Current Sense Blanking Time has expired. A fault occurs after this limit is exceeded. The recommended peak OCP limit is determined by [\(EQ. 2\)](#).

$$(EQ. 2) \quad IOUT\_OC\_FAULT\_LIMIT = (IOUT\_AVG\_OC\_FAULT\_LIMIT + 0.5 \cdot I_{RIPPLE\_P\_P}) \cdot 130\%$$

A hard bound of 50A is applied to the command value. This feature shares the OC fault bit operation (in STATUS\_IOUT) and OC fault response with the IOUT\_AVG\_OC\_FAULT\_LIMIT.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** E320h (50A)

**Units:** A

**Range:** -100A to 100A



**IOUT\_OC\_WARN\_LIMIT (4Ah)**

**Definition:** Sets the I<sub>OUT</sub> average overcurrent warning threshold.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** IOUT\_AVG\_OC\_FAULT\_LIMIT x 0.9

**Units:** A

**Range:** -100A to 100A

**IOUT\_UC\_FAULT\_LIMIT (4Bh)**

**Definition:** Sets the I<sub>OUT</sub> valley undercurrent fault threshold. This limit is applied to current measurement samples taken after the Current Sense Blanking Time has expired. A fault occurs after this limit is exceeded. The recommended valley UCP limit is determined by [\(EQ. 3\)](#):

$$(EQ. 3) \quad IOUT\_UC\_FAULT\_LIMIT = (IOUT\_AVG\_UC\_FAULT\_LIMIT - 0.5 \cdot I_{RIPPLE\_P\_P}) \cdot 130\%$$

A hard bound of -50A is applied to the command value. This feature shares the UC fault bit operation (in STATUS\_IOUT) and UC fault response with IOUT\_AVG\_UC\_FAULT\_LIMIT.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** E4E0 (-50A)

**Units:** A

**Range:** -100A to 100A

**OT\_FAULT\_LIMIT (4Fh)**

**Definition:** Sets the temperature at which the device should indicate an over-temperature fault. Note that the temperature must drop below OT\_WARN\_LIMIT to clear this fault.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** EB98 (+115°C)

**Units:** °C

**Range:** 0°C to +175°C

**OT\_FAULT\_RESPONSE (50h)**

**Definition:** Instructs the device on what action to take in response to an over-temperature fault.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Fault Value:** 80h (Disable and no retry)

**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1)*35ms. Sets the time between retries in 35ms increments. Range is 35ms to 280ms.                                                                                                                         |

**OT\_WARN\_LIMIT (51h)**

**Definition:** Sets the temperature at which the device should indicate an over-temperature warning alarm. In response to the OT\_WARN\_LIMIT being exceeded, the device sets the TEMPERATURE bit in STATUS\_WORD, sets the OT\_WARNING bit in STATUS\_TEMPERATURE, and notifies the host.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** EB48h (+105°C)

**Units:** °C

**Range:** 0°C to +175°C

**UT\_WARN\_LIMIT (52h)**

**Definition:** Sets the temperature at which the device should indicate an under-temperature warning alarm. In response to the UT\_WARN\_LIMIT being exceeded, the device sets the TEMPERATURE bit in STATUS\_WORD, sets the UT\_WARNING bit in STATUS\_TEMPERATURE, and notifies the host.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** DC40h (-30°C)

**Units:** °C

**Range:** -55°C to +25°C

**UT\_FAULT\_LIMIT (53h)**

**Definition:** Sets the temperature, in degrees Celsius, of the unit where it should indicate an under-temperature fault. Note that the temperature must rise above UT\_WARN\_LIMIT to clear this fault.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** E530h (-45°C)

**Units:** °C

**Range:** -55°C to +25°C

**UT\_FAULT\_RESPONSE (54h)**

**Definition:** Configures the under-temperature fault response as defined by the following table. The delay time is the time between restart attempts.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 80h (Disable, no retry)

**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1) * 35ms. Sets the time between retries in 35ms increments. Range is 35ms to 280ms.                                                                                                                       |

**VIN\_OV\_FAULT\_LIMIT (55h)**

**Definition:** Sets the  $V_{IN}$  overvoltage fault threshold.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** D3A0 (14.5V)

**Units:** V

**Range:** 0V to 16V

**VIN\_OV\_FAULT\_RESPONSE (56h)**

**Definition:** Configures the  $V_{IN}$  overvoltage fault response as defined by the following table. The delay time is the time between restart attempts.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 80h (Disable and no retry)

**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1) * 35ms. Sets the time between retries in 35ms increments. Range is 35ms to 280ms.                                                                                                                       |

**VIN\_OV\_WARN\_LIMIT (57h)**

**Definition:** Sets the  $V_{IN}$  overvoltage warning threshold. In response to the OV\_WARN\_LIMIT being exceeded, the device sets the NONE OF THE ABOVE and INPUT bits in STATUS\_WORD, sets the VIN\_OV\_WARNING bit in STATUS\_INPUT, and notifies the host.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Protectable:** Yes

**Default Value:** D353h (13.3V)

**Units:** V

**Range:** 0V to 16V

**VIN\_UV\_WARN\_LIMIT (58h)**

**Definition:** Sets the  $V_{IN}$  undervoltage warning threshold. If a VIN\_UV\_FAULT occurs, the input voltage must rise above VIN\_UV\_WARN\_LIMIT to clear the fault, which provides hysteresis to the fault threshold. In response to the UV\_WARN\_LIMIT being exceeded, the device sets the NONE OF THE ABOVE and INPUT bits in STATUS\_WORD, sets the VIN\_UV\_WARNING bit in STATUS\_INPUT, and notifies the host.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** 1.03 x VIN\_UV\_FAULT\_LIMIT pin-strap setting

**Units:** V

**Range:** 0V to 12V

**VIN\_UV\_FAULT\_LIMIT (59h)****Definition:** Sets the  $V_{IN}$  undervoltage fault threshold.**Data Length in Bytes:** 2**Data Format:** L11**Type:** R/W**Default Value:** Pin-strap setting**Units:** V**Range:** 0V to 12V**VIN\_UV\_FAULT\_RESPONSE (5Ah)****Definition:** Configures the  $V_{IN}$  undervoltage fault response as defined by the following table. The delay time is the time between restart attempts.**Data Length in Bytes:** 1**Data Format:** BIT**Type:** R/W**Default Value:** 80h (Disable and no retry)**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1)*35ms. Sets the time between retries in 35ms increments. Range is 35ms to 280ms.                                                                                                                         |

**POWER\_GOOD\_ON (5Eh)****Definition:** Sets the voltage threshold for power-good indication. Power-good asserts with a delay specified in POWER\_GOOD\_DELAY after the output voltage exceeds POWER\_GOOD\_ON and deasserts when the output voltage is less than VOUT\_UV\_WARN\_LIMIT. It is recommended to set POWER\_GOOD\_ON higher than VOUT\_UV\_FAULT\_LIMIT.**Data Length in Bytes:** 2**Data Format:** L16u**Type:** R/W**Default Value:** 0.9xVOUT\_COMMAND pin-strap setting**Units:** V

**TON\_DELAY (60h)**

**Definition:** Sets the delay time from when the device is enabled to the start of  $V_{OUT}$  rise.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Pin-strap setting

**Units:** ms

**Range:** 2ms to 256ms

**TON\_RISE (61h)**

**Definition:** Sets the rise time of  $V_{OUT}$  after ENABLE and TON\_DELAY. In multi-module current sharing configuration where ASCR is disabled for start up, the rise time of  $V_{OUT}$  can be approximately calculated by [\(EQ. 1\)](#).

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Pin-strap setting

**Units:** ms

**Range:** 0ms to 100ms

**TOFF\_DELAY (64h)**

**Definition:** Sets the delay time from DISABLE to start of  $V_{OUT}$  fall.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Pin-strap setting

**Units:** ms

**Range:** 0ms to 256ms

**TOFF\_FALL (65h)**

**Definition:** Sets the soft-off fall time for  $V_{OUT}$  after DISABLE and TOFF\_DELAY.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** Pin-strap setting

**Units:** ms

**Range:** 0ms to 100ms

**STATUS\_BYTE (78h)**

**Definition:** Returns one byte of information with a summary of the most critical faults.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** Read Only

**Default Value:** 00h

**Units:** N/A

| Bit Number | Status Bit Name   | Meaning                                                                                                                              |
|------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------|
| 7          | BUSY              | A fault was declared because the device was busy and unable to respond.                                                              |
| 6          | OFF               | This bit is asserted if the unit is not providing power to the output, regardless of the reason, including simply not being enabled. |
| 5          | VOUT_OV_FAULT     | An output overvoltage fault has occurred.                                                                                            |
| 4          | IOUT_OC_FAULT     | An output overcurrent fault has occurred.                                                                                            |
| 3          | VIN_UV_FAULT      | An input undervoltage fault has occurred.                                                                                            |
| 2          | TEMPERATURE       | A temperature fault or warning has occurred.                                                                                         |
| 1          | CML               | A communications, memory, or logic fault has occurred.                                                                               |
| 0          | NONE OF THE ABOVE | A fault or warning not listed in Bits 7:1 has occurred.                                                                              |

**STATUS\_WORD (79h)**

**Definition:** Returns two bytes of information with a summary of the unit's fault condition. Based on the information in these bytes, the host can get more information by reading the appropriate status registers. The low byte of the STATUS\_WORD is the same register as the STATUS\_BYTE (78h) command.

**Data Length in Bytes:** 2

**Data Format:** BIT

**Type:** Read Only

**Default Value:** 0000h

**Units:** N/A

| Bit Number | Status Bit Name   | Meaning                                                                                                                              |
|------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------|
| 15         | VOUT              | An output voltage fault or warning has occurred.                                                                                     |
| 14         | IOUT/POUT         | An output current or output power fault or warning has occurred.                                                                     |
| 13         | INPUT             | An input voltage, input current, or input power fault or warning has occurred.                                                       |
| 12         | MFG_SPECIFIC      | A manufacturer specific fault or warning has occurred.                                                                               |
| 11         | POWER_GOOD#       | The POWER_GOOD signal, if present, is negated.                                                                                       |
| 10         | FANS              | A fan or airflow fault or warning has occurred.                                                                                      |
| 9          | OTHER             | A bit in STATUS_OTHER is set.                                                                                                        |
| 8          | UNKNOWN           | A fault type not given in Bits 15:1 of the STATUS_WORD has been detected.                                                            |
| 7          | BUSY              | A fault was declared because the device was busy and unable to respond.                                                              |
| 6          | OFF               | This bit is asserted if the unit is not providing power to the output, regardless of the reason, including simply not being enabled. |
| 5          | VOUT_OV_FAULT     | An output overvoltage fault has occurred.                                                                                            |
| 4          | IOUT_OC_FAULT     | An output overcurrent fault has occurred.                                                                                            |
| 3          | VIN_UV_FAULT      | An input undervoltage fault has occurred.                                                                                            |
| 2          | TEMPERATURE       | A temperature fault or warning has occurred.                                                                                         |
| 1          | CML               | A communications, memory, or logic fault has occurred.                                                                               |
| 0          | NONE OF THE ABOVE | A fault or warning not listed in Bits 7:1 has occurred.                                                                              |

**STATUS\_VOUT (7Ah)**

**Definition:** Returns one data byte with the status of the output voltage.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** Read Only

**Default Value:** 00h

**Units:** N/A

| Bit Number | Status Bit Name | Meaning                                   |
|------------|-----------------|-------------------------------------------|
| 7          | VOUT_OV_FAULT   | Indicates an output overvoltage fault.    |
| 6          | VOUT_OV_WARNING | Indicates an output overvoltage warning.  |
| 5          | VOUT_UV_WARNING | Indicates an output undervoltage warning. |
| 4          | VOUT_UV_FAULT   | Indicates an output undervoltage fault.   |
| 3:0        | N/A             | These bits are not used.                  |



**STATUS\_IOUT (7Bh)****Definition:** Returns one data byte with the status of the output current.**Data Length in Bytes:** 1**Data Format:** BIT**Type:** Read Only**Default Value:** 00h**Units:** N/A

| Bit Number | Status Bit Name  | Meaning                                                   |
|------------|------------------|-----------------------------------------------------------|
| 7          | IOUT_OC_FAULT    | An output overcurrent fault has occurred.                 |
| 6          | IOUT_OC_LV_FAULT | An output overcurrent and low voltage fault has occurred. |
| 5          | IOUT_OC_WARNING  | An output overcurrent warning has occurred.               |
| 4          | IOUT_UC_FAULT    | An output undercurrent fault has occurred.                |
| 3:0        | N/A              | These bits are not used.                                  |

**STATUS\_INPUT (7Ch)****Definition:** Returns the input voltage and input current status information.**Data Length in Bytes:** 1**Data Format:** BIT**Type:** Read Only**Default Value:** 00h**Units:** N/A

| Bit Number | Status Bit Name | Meaning                                     |
|------------|-----------------|---------------------------------------------|
| 7          | VIN_OV_FAULT    | An input overvoltage fault has occurred.    |
| 6          | VIN_OV_WARNING  | An input overvoltage warning has occurred.  |
| 5          | VIN_UV_WARNING  | An input undervoltage warning has occurred. |
| 4          | VIN_UV_FAULT    | An input undervoltage fault has occurred.   |
| 3:0        | N/A             | These bits are not used.                    |

**STATUS\_TEMP (7Dh)****Definition:** Returns one byte of information with a summary of any temperature related faults or warnings.**Data Length in Bytes:** 1**Data Format:** BIT**Type:** Read Only**Default Value:** 00h**Units:** N/A

| Bit Number | Status Bit Name | Meaning                                    |
|------------|-----------------|--------------------------------------------|
| 7          | OT_FAULT        | An over-temperature fault has occurred.    |
| 6          | OT_WARNING      | An over-temperature warning has occurred.  |
| 5          | UT_WARNING      | An under-temperature warning has occurred. |
| 4          | UT_FAULT        | An under-temperature fault has occurred.   |
| 3:0        | N/A             | These bits are not used.                   |

**STATUS\_CML (7Eh)**

**Definition:** Returns one byte of information with a summary of any communications, logic, and/or memory errors.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** Read Only

**Default Value:** 00h

**Units:** N/A

| Bit Number | Meaning                                                                                                                                             |
|------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|
| 7          | Invalid or unsupported PMBus command was received.                                                                                                  |
| 6          | The PMBus command was sent with invalid or unsupported data.                                                                                        |
| 5          | Packet error was detected in the PMBus command.                                                                                                     |
| 4:2        | Not used                                                                                                                                            |
| 1          | A PMBus command tried to write to a read-only or protected command, or a communication fault other than the ones listed in this table has occurred. |
| 0          | Not used                                                                                                                                            |

**STATUS\_MFR\_SPECIFIC (80h)**

**Definition:** Returns one byte of information providing the status of the device's voltage monitoring and clock synchronization faults. VMON OV/UV warnings are set at  $\pm 10\%$  of the VMON\_FAULT commands.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** Read only

**Default value:** 00h

**Units:** N/A

| Bit Number | Field Name                      | Meaning                                                                                 |
|------------|---------------------------------|-----------------------------------------------------------------------------------------|
| 7:6        | Reserved                        |                                                                                         |
| 5          | VMON UV Warning                 | The voltage on the VMON pin has dropped 10% below the level set by VMON_UV_FAULT_LIMIT. |
| 4          | VMON OV Warning                 | The voltage on the VMON pin has risen 10% above the level set by VMON_OV_FAULT_LIMIT.   |
| 3          | External Switching Period Fault | Loss of external clock synchronization has occurred.                                    |
| 2          | Reserved                        |                                                                                         |
| 1          | VMON UV Fault                   | The voltage on the VMON pin has dropped below the level set by VMON_UV_FAULT_LIMIT.     |
| 0          | VMON OV Fault                   | The voltage on the VMON pin has risen above the level set by VMON_OV_FAULT_LIMIT.       |

**READ\_VIN (88h)**

**Definition:** Returns the input voltage reading.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read Only

**Units:** V

**READ\_VOUT (8Bh)**

**Definition:** Returns the output voltage reading.

**Data Length in Bytes:** 2

**Data Format:** L16u

**Type:** Read Only

**Units:** V

**READ\_IOUT (8Ch)**

**Definition:** Returns the output current reading.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read Only

**Default Value:** N/A

**Units:** A

**READ\_INTERNAL\_TEMP (8Dh)**

**Definition:** Returns the controller junction temperature reading from the internal temperature sensor.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read Only

**Units:** °C

**READ\_DUTY\_CYCLE (94h)**

**Definition:** Reports the actual duty cycle of the converter during the enable state.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read only

**Units:** %

**READ\_FREQUENCY (95h)**

**Definition:** Reports the actual switching frequency of the converter during the enable state.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read only

**Units:** kHz

**MFR\_ID (99h)**

**Definition:** Sets user defined identification. The sum total of characters in MFR\_ID, MFR\_MODEL, MFR\_REVISION, MFR\_LOCATION, MFR\_DATE, MFR\_SERIAL, and USER\_DATA\_00 plus one byte per command cannot exceed 128 characters. This limitation includes multiple writes of this command before a STORE command. To clear multiple writes, perform a RESTORE, write this command then perform a STORE/RESTORE.

**Data Length in Bytes:** User defined

**Data Format:** ASC

**Type:** Block R/W

**Default Value:** Null

**Units:** N/A

**MFR\_MODEL (9Ah)**

**Definition:** Sets a user defined model. The sum total of characters in MFR\_ID, MFR\_MODEL, MFR\_REVISION, MFR\_LOCATION, MFR\_DATE, MFR\_SERIAL, and USER\_DATA\_00 plus one byte per command cannot exceed 128 characters. This limitation includes multiple writes of this command before a STORE command. To clear multiple writes, perform a RESTORE, write this command then perform a STORE/RESTORE.

**Data Length in Bytes:** User defined

**Data Format:** ASC

**Type:** Block R/W

**Default Value:** Null

**Units:** N/A

**MFR\_REVISION (9Bh)**

**Definition:** Sets a user defined revision. The sum total of characters in MFR\_ID, MFR\_MODEL, MFR\_REVISION, MFR\_LOCATION, MFR\_DATE, MFR\_SERIAL, and USER\_DATA\_00 plus one byte per command cannot exceed 128 characters. This limitation includes multiple writes of this command before a STORE command. To clear multiple writes, perform a RESTORE, write this command then perform a STORE/RESTORE.

**Data Length in Bytes:** User defined

**Data Format:** ASC

**Type:** Block R/W

**Default Value:** Null

**Units:** N/A

**MFR\_LOCATION (9Ch)**

**Definition:** Sets a user defined location identifier. The sum total of characters in MFR\_ID, MFR\_MODEL, MFR\_REVISION, MFR\_LOCATION, MFR\_DATE, MFR\_SERIAL, and USER\_DATA\_00 plus one byte per command cannot exceed 128 characters. This limitation includes multiple writes of this command before a STORE command. To clear multiple writes, perform a RESTORE, write this command then perform a STORE/RESTORE.

**Data Length in Bytes:** User defined

**Data Format:** ASC

**Type:** Block R/W

**Default Value:** Null

**Units:** N/A

**MFR\_DATE (9Dh)**

**Definition:** Sets a user defined date. The sum total of characters in MFR\_ID, MFR\_MODEL, MFR\_REVISION, MFR\_LOCATION, MFR\_DATE, MFR\_SERIAL, and USER\_DATA\_00 plus one byte per command cannot exceed 128 characters. This limitation includes multiple writes of this command before a STORE command. To clear multiple writes, perform a RESTORE, write this command then perform a STORE/RESTORE.

**Data Length in Bytes:** User defined

**Data Format:** ASC

**Type:** Block R/W

**Default Value:** Null

**Units:** N/A

**Reference:** N/A

**MFR\_SERIAL (9Eh)**

**Definition:** Sets a user defined serialized identifier. The sum total of characters in MFR\_ID, MFR\_MODEL, MFR\_REVISION, MFR\_LOCATION, MFR\_DATE, MFR\_SERIAL, and USER\_DATA\_00 plus one byte per command cannot exceed 128 characters. This limitation includes multiple writes of this command before a STORE command. To clear multiple writes, perform a RESTORE, write this command then perform a STORE/RESTORE.

**Data Length in Bytes:** User defined

**Data Format:** ASC

**Type:** Block R/W

**Default Value:** Null

**Units:** N/A

**LEGACY\_FAULT\_GROUP (A8h)**

**Definition:** Sets which rail DDC IDs should be listened to for fault spreading with legacy devices. The data sent is a 4-byte, 32-bit, bit vector where every bit represents a rail's DDC ID. A bit set to 1 indicates a device DDC ID to which the configured device will respond upon receiving a fault spreading event. In this vector, Bit 0 of byte 0 corresponds to the rail with DDC ID 0. Following through, Bit 7 of byte 3 corresponds to the rail with DDC ID 31.

**Data Length in Bytes:** 4

**Data Format:** BIT

**Type:** Block R/W

**Default Value:** 00000000h (No rail ID specified)

**USER\_DATA\_00 (B0h)**

**Definition:** Sets user defined data. The sum total of characters in MFR\_ID, MFR\_MODEL, MFR\_REVISION, MFR\_LOCATION, MFR\_DATE, MFR\_SERIAL, and USER\_DATA\_00 plus one byte per command cannot exceed 128 characters. This limitation includes multiple writes of this command before a STORE command. To clear multiple writes, perform a RESTORE, write this command then perform a STORE/RESTORE.

**Data Length in Bytes:** User defined

**Data Format:** ASC

**Type:** Block R/W

**Default Value:** Null

**Units:** N/A

**ISENSE\_CONFIG (D0h)**

**Definition:** Configures current sense circuitry.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 06h (256ns current sense blanking time, current sense high range)

**Units:** N/A

| Bit | Field Name                  | Value | Setting    | Description                                         |
|-----|-----------------------------|-------|------------|-----------------------------------------------------|
| 7:4 | Reserved                    | 0000  |            |                                                     |
| 3:2 | Current Sense Blanking Time | 00    | 192ns      | Sets the blanking time current sense blanking time. |
|     |                             | 01    | 256ns      |                                                     |
|     |                             | 10    | 412ns      |                                                     |
|     |                             | 11    | 640ns      |                                                     |
| 1:0 | Current Sense Range         | 00    | Low Range  | ±25mV                                               |
|     |                             | 01    | Mid Range  | ±35mV                                               |
|     |                             | 10    | High Range | ±50mV                                               |
|     |                             | 11    | Not Used   |                                                     |

**USER\_CONFIG (D1h)**

**Definition:** Configures several user-level features. This command overrides the pin-strap settings.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 84h (Pin-strap setting for ASCR on Start up; ramp-up and ramp-down minimum duty cycle 0.39%; minimum duty cycle control enabled; PG is an open-drain output.)

**Units:** N/A

| Bit | Field Name                               | Value | Setting    | Description                                                       |
|-----|------------------------------------------|-------|------------|-------------------------------------------------------------------|
| 7   | ASCR on for Start up                     | 0     | Disabled   | ASCR is disabled for start up. Use this for Current Sharing mode. |
|     |                                          | 1     | Enabled    | ASCR is enabled for start up. Use this for Stand Alone mode.      |
| 6:5 | Reserved                                 | 00    |            | Reserved                                                          |
| 4:3 | Ramp-up and Ramp-down Minimum Duty Cycle | 00    | 0.39%      | Sets the minimum duty-cycle during start-up and shutdown ramp.    |
|     |                                          | 01    | 0.78%      |                                                                   |
|     |                                          | 10    | 1.17%      |                                                                   |
|     |                                          | 11    | 1.56%      |                                                                   |
| 2   | Minimum Duty Cycle Control               | 0     | Disable    | Control for minimum duty cycle.                                   |
|     |                                          | 1     | Enable     |                                                                   |
| 1   | Power-good Pin Configuration             | 0     | Open Drain | 0 = PG is an open-drain output.                                   |
|     |                                          | 1     | Push-Pull  | 1 = PG is a push-pull output.                                     |
| 0   | Reserved                                 | 0     |            |                                                                   |

**DDC\_CONFIG (D3h)**

**Definition:** Configures DDC addressing and current sharing. The DDC rail ID is set according to the SMBus address. For current sharing applications, the DDC Phase ID is set according to the number of phases. The device position and number of devices in the rail can be programmed as needed.

**Data Length in Bytes:** 2

**Data Format:** BIT

**Type:** R/W

**Default Value:** Pin-strap setting for Rail ID. Phase ID = 0; Phases in rail = 1

**Units:** N/A

| Bit   | Field Name     | Value               | Setting  | Description                                            |
|-------|----------------|---------------------|----------|--------------------------------------------------------|
| 15:13 | Phase ID       | 0 to 7              |          | Sets the phase ID in a current sharing rail.           |
| 12:8  | Rail ID        | 0 to 31 (00 to 1Fh) |          | Configures DDC rail ID                                 |
| 7:3   | Reserved       | 0                   | Reserved | Reserved                                               |
| 2:0   | Phases in Rail | 0 to 7              |          | Identifies the number of phases on the same rail (+1). |

**POWER\_GOOD\_DELAY (D4h)**

**Definition:** Sets the delay applied between the output exceeding the PG threshold (POWER\_GOOD\_ON) and asserting the PG pin. The delay time can range from 0ms up to 500s, in steps of 125ns. A 1ms minimum configured value is recommended to apply proper debounce to this signal.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** R/W

**Default Value:** C300h, 3ms

**Units:** ms

**Range:** 0ms to 5s

**ASCR\_CONFIG (DFh)**

**Definition:** Allows user configuration of ASCR settings. ASCR gain is analogous to bandwidth, ASCR residual is analogous to damping. To improve load transient response performance, increase ASCR gain. To lower transient response overshoot, increase ASCR residual. Increasing ASCR gain can result in increased PWM jitter and should be evaluated in the application circuit. Excessive ASCR gain can lead to excessive output voltage ripple. Increasing ASCR residual to improve transient response damping can result in slower recovery times, but will not affect the peak output voltage deviation. Typical ASCR gain settings range from 50 to 1000, and ASCR residual settings range from 10 to 100.

**Data Length in Bytes:** 4

**Data Format:** CUS

**Type:** R/W

**Default Value:** Pin-strap setting

| Bit   | Purpose               | Data Format | Value    | Description   |
|-------|-----------------------|-------------|----------|---------------|
| 31:25 | Unused                |             | 0000000h | Unused        |
| 24    | ASCR Enable           | BIT         | 1        | Enable        |
|       |                       |             | 0        | Disable       |
| 23:16 | ASCR Residual Setting | Integer     |          | ASCR residual |
| 15:0  | ASCR Gain Setting     | Integer     |          | ASCR gain     |



**SEQUENCE (E0h)**

**Definition:** Identifies the Rail DDC ID of the prequel and sequel rails when performing multi-rail sequencing. The device will enable its output when its EN or OPERATION enable states, as defined by ON\_OFF\_CONFIG, is set and the prequel device has issued a power-good event on the DDC bus. The device will disable its output (using the programmed delay values) when the sequel device has issued a power-down event on the DDC bus.

The data field is a two-byte value. The most significant byte contains the 5-bit Rail DDC ID of the prequel device. The Least Significant Byte (LSB) contains the 5-bit Rail DDC ID of the sequel device. The Most Significant Bit (MSB) of each byte contains the enable of the prequel or sequel mode. This command overrides the corresponding sequence configuration set by the CONFIG pin settings.

**Data Length in Bytes:** 2

**Data Format:** BIT

**Type:** R/W

**Default Value:** 0000h (Prequel and Sequel disabled)

| Bit   | Field Name          | Value | Setting  | Description                                           |
|-------|---------------------|-------|----------|-------------------------------------------------------|
| 15    | Prequel Enable      | 0     | Disable  | Disable, no prequel preceding this rail.              |
|       |                     | 1     | Enable   | Enable, prequel to this rail is defined by Bits 12:8. |
| 14:13 | Reserved            | 0     | Reserved | Reserved                                              |
| 12:8  | Prequel Rail DDC ID | 0-31  | DDC ID   | Set to the DDC ID of the prequel rail.                |
| 7     | Sequel Enable       | 0     | Disable  | Disable, no sequel following this rail.               |
|       |                     | 1     | Enable   | Enable, sequel to this rail is defined by Bits 4:0.   |
| 6:5   | Reserved            | 0     | Reserved | Reserved                                              |
| 4:0   | Sequel Rail DDC ID  | 0-31  | DDC ID   | Set to the DDC ID of the sequel rail.                 |

**TRACK\_CONFIG (E1h)**

**Definition:** Configures the voltage tracking modes of the device. Only one channel can be configured to track: Channel 1 or Channel 2.

Data Length in Bytes: 1

Data Format: BIT

Type: R/W

Default Value: Pin-strap setting based on SS/TRACK

| Bit | Field Name               | Value | Setting        | Description                                                     |
|-----|--------------------------|-------|----------------|-----------------------------------------------------------------|
| 7   | Voltage Tracking Control | 0     | Disable        | Tracking is disabled                                            |
|     |                          | 1     | Enable         | Tracking is enabled                                             |
| 6:3 | Reserved                 | 0000  | Reserved       | Reserved                                                        |
| 2   | Tracking Ratio Control   | 0     | 100%           | Output tracks at 100% ratio of VTRK input                       |
|     |                          | 1     | 50%            | Output tracks at 50% ratio of VTRK input                        |
| 1   | Tracking Upper Limit     | 0     | Target Voltage | Output voltage is limited by target voltage                     |
|     |                          | 1     | VTRK Voltage   | Output voltage is limited by VTRK voltage                       |
| 0   | Ramp-Up Behavior         | 0     | Track after PG | The output is not allowed to track VTRK down before power-good. |
|     |                          | 1     | Track always   | The output is allowed to track VTRK down before power-good.     |

**DDC\_GROUP (E2h)**

**Definition:** Configures fault spreading group ID and enable, broadcast OPERATION group ID and enable, and Broadcast VOUT\_COMMAND group ID and enable.

Data Length in Bytes: 3

Data Format: BIT

Type: Block R/W

Default Value: Ignore Broadcast VOUT\_COMMAND, OPERATION.

| Bits  | Purpose                         | Value | Description                                                                    |
|-------|---------------------------------|-------|--------------------------------------------------------------------------------|
| 23:22 | Reserved                        | 0     | Reserved                                                                       |
| 21    | BROADCAST_VOUT_COMMAND Response | 1     | Responds to BROADCAST_VOUT_COMMAND with same Group ID.                         |
|       |                                 | 0     | Ignores BROADCAST_VOUT_COMMAND.                                                |
| 20:16 | BROADCAST_VOUT_COMMAND Group ID | 0-31d | Group ID sent as data for broadcast BROADCAST_VOUT_COMMAND events.             |
| 15:14 | Reserved                        | 0     | Reserved                                                                       |
| 13    | BROADCAST_OPERATION Response    | 1     | Responds to BROADCAST_OPERATION with same Group ID.                            |
|       |                                 | 0     | Ignores BROADCAST_OPERATION.                                                   |
| 12:8  | BROADCAST_OPERATION Group ID    | 0-31d | Group ID sent as data for broadcast BROADCAST_OPERATION events.                |
| 7:6   | Reserved                        | 0     | Reserved                                                                       |
| 5     | POWER_FAIL Response             | 1     | Responds to POWER_FAIL events with same Group ID by shutting down immediately. |
|       |                                 | 0     | Responds to POWER_FAIL events with same Group ID with sequenced shutdown.      |
| 4:0   | POWER_FAIL group ID             | 0-31d | Group ID sent as data for broadcast POWER_FAIL events.                         |

**DEVICE\_ID (E4h)**

**Definition:** Returns the 16-byte (character) device identifier string.

**Data Length in Bytes:** 16

**Data Format:** ASC

**Type:** Block Read

**Default Value:** Part number/Die revision/Firmware revision

**MFR\_IOUT\_OC\_FAULT\_RESPONSE (E5h)**

**Definition:** Configures the I<sub>OUT</sub> overcurrent fault response as defined by the following table. The command format is the same as the PMBus standard fault responses except that it sets the overcurrent status bit in STATUS\_IOUT.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 80h (Disable, and no retry)

**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1)*35ms. Sets the time between retries in 35ms increments. Range is 35ms to 280ms.                                                                                                                         |

**MFR\_IOUT\_UC\_FAULT\_RESPONSE (E6h)**

**Definition:** Configures the I<sub>OUT</sub> undercurrent fault response as defined by the following table. The command format is the same as the PMBus standard fault responses except that it sets the undercurrent status bit in STATUS\_IOUT.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** 80h (Disable and no retry)

**Units:** N/A

| Bit | Field Name    | Value   | Description                                                                                                                                                                                                                            |
|-----|---------------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:6 | Reserved      | 10      |                                                                                                                                                                                                                                        |
| 5:3 | Retry Setting | 000     | No retry. The output remains disabled until the fault is cleared.                                                                                                                                                                      |
|     |               | 001-110 | Not used.                                                                                                                                                                                                                              |
|     |               | 111     | Attempts to restart continuously, without checking if the fault is still present, until it is commanded OFF (by the CONTROL pin or OPERATION command), bias power is removed, or another fault condition causes the unit to shut down. |
| 2:0 | Retry Delay   | 000-111 | Retry delay time = (Value + 1)*35ms. Sets the time between retries in 35ms increments. Range is 35ms to 280ms.                                                                                                                         |

**IOUT\_AVG\_OC\_FAULT\_LIMIT (E7h)**

**Definition:** Sets the  $I_{OUT}$  average overcurrent fault threshold. For down-slope sensing, this corresponds to the average of all the current samples taken during the (1-D) time interval, excluding the current sense blanking time (which occurs at the beginning of the 1-D interval). For up-slope sensing, this corresponds to the average of all the current samples taken during the D time interval, excluding the current sense blanking time (which occurs at the beginning of the D interval). This feature shares the OC fault bit operation (in STATUS\_IOUT) and OC fault response with IOUT\_OC\_FAULT\_LIMIT.

**Paged or Global:** Paged

**Data Length in Bytes:** 2

**Data Format:** Linear-11

**Type:** R/W

**Protectable:** Yes

**Default Value:** SYNC/OCP pin-strap setting

**Units:** A

**Equation:**  $IOUT\_AVG\_OC\_FAULT\_LIMIT = Y \times 2N$

**Range:** -100A to 100A

**IOUT\_AVG\_UC\_FAULT\_LIMIT (E8h)**

**Definition:** Sets the  $I_{OUT}$  average undercurrent fault threshold. For down-slope sensing, this corresponds to the average of all the current samples taken during the (1-D) time interval, excluding the current sense blanking time (which occurs at the beginning of the 1-D interval). For up-slope sensing, this corresponds to the average of all the current samples taken during the D time interval, excluding the current sense blanking time (which occurs at the beginning of the D interval). This feature shares the UC fault bit operation (in STATUS\_IOUT) and UC fault response with IOUT\_UC\_FAULT\_LIMIT.

**Paged or Global:** Paged

**Data Length in Bytes:** 2

**Data Format:** Linear-11

**Type:** R/W

**Protectable:** Yes

**Default Value:** DC40h (-30A)

**Units:** A

**Equation:**  $IOUT\_AVG\_UC\_FAULT\_LIMIT = Y \times 2N$

**Range:** -100A to 100A

**SYNC\_CONFIG (E9h)**

**Definition:** Used to set options for SYNC output configurations.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** R/W

**Default Value:** Pin-strap setting

| Settings | Actions                                                                   |
|----------|---------------------------------------------------------------------------|
| 00h      | Use internal clock. Clock frequency is set by pin-strap or PMBus command. |
| 02h      | Use internal clock and output internal clock.                             |
| 04h      | Use external clock.                                                       |

**SNAPSHOT (EAh)**

**Definition:** A 32-byte read-back of parametric and status values. It allows monitoring and status data to be stored to flash following a fault condition. In case of a fault, last updated values are stored to the flash memory. When the SNAPSHOT STATUS bit is set stored, device will no longer automatically capture parametric and status values following fault till stored data are erased. Use the SNAPSHOT\_CONTROL command to erase store data and clear the status bit before next ramp up. Data erased is not allowed when module is enabled.

**Data Length in Bytes:** 32

**Data Format:** Bit field

**Type:** Block Read

| Byte Number | Value                                                      | PMBus Command             | Format |
|-------------|------------------------------------------------------------|---------------------------|--------|
| 31:23       | Reserved                                                   | Reserved                  | 00h    |
| 22          | Flash Memory Status Byte<br>FF - Not Stored<br>00 - Stored | N/A                       | BIT    |
| 21          | Manufacturer Specific Status Byte                          | STATUS_MFR_SPECIFIC (80h) | Byte   |
| 20          | CML Status Byte                                            | STATUS_CML (7Eh)          | Byte   |
| 19          | Temperature Status Byte                                    | STATUS_TEMPERATURE (7Dh)  | Byte   |
| 18          | Input Status Byte                                          | STATUS_INPUT (7Ch)        | Byte   |
| 17          | I <sub>OUT</sub> Status Byte                               | STATUS_IOUT (7Bh)         | Byte   |
| 16          | V <sub>OUT</sub> Status Byte                               | STATUS_VOUT (7Ah)         | Byte   |
| 15:14       | Switching Frequency                                        | READ_FREQUENCY (95h)      | L11    |
| 13:12       | Reserved                                                   | Reserved                  | 00h    |
| 11:10       | Internal Temperature                                       | READ_INTERNAL_TEMP (8Dh)  | L11    |
| 9:8         | Duty Cycle                                                 | READ_DUTY_CYCLE (94h)     | L11    |
| 7:6         | Highest Measured Output Current                            | N/A                       | L11    |
| 5:4         | Output Current                                             | READ_IOUT (8Ch)           | L11    |
| 3:2         | Output Voltage                                             | READ_VOUT (8Bh)           | L16u   |
| 1:0         | Input Voltage                                              | READ_VIN (88h)            | L11    |

**BLANK\_PARAMS (EBh)**

**Definition:** Returns a 16-byte string indicating which parameter values were either retrieved by the last RESTORE operation or have been written since that time. Reading BLANK\_PARAMS immediately after a restore operation allows the user to determine which parameters are stored in that store. A “1” indicates the parameter is not present in the store and has not been written since the RESTORE operation.

**Data Length in Bytes:** 16

**Data Format:** BIT

**Type:** Block Read

**Default Value:** FF...FFh

**SNAPSHOT\_CONTROL (F3h)**

**Definition:** Writing a 01h will cause the device to copy the current Snapshot values from NVRAM to the 32-byte Snapshot command parameter. Writing a 02h will cause the device to write the current Snapshot values to NVRAM. Writing a 03h will erase all Snapshot values from NVRAM. Write (02h) and Erase (03h) may only be used when the device is disabled. All other values will be ignored.

**Data Length in Bytes:** 1

**Data Format:** Bit field

**Type:** R/W byte

| Value | Description                             |
|-------|-----------------------------------------|
| 01h   | Read Snapshot values from NV RAM        |
| 02h   | Write Snapshot values to NV RAM         |
| 03h   | Erase Snapshot values stored in NV RAM. |

**RESTORE\_FACTORY (F4h)**

**Definition:** Restores the device to the hard coded factory default values and pin-strap definitions. The device retains the DEFAULT and USER stores for restoring. Security level is changed to Level 1 following this command.

**Data Length in Bytes:** 0

**Data Format:** N/A

**Type:** Send byte

**Default Value:** N/A

**Units:** N/A

**MFR\_VMON\_OV\_FAULT\_LIMIT (F5h)**

**Definition:** Reads the VMON OV fault threshold.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read only

**Default Value:** CB00h (6V)

**Units:** V

**Range:** 4V to 6V

**MFR\_VMON\_UV\_FAULT\_LIMIT (F6h)**

**Definition:** Reads the VMON UV fault threshold.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read only

**Default Value:** CA00h (4V)

**Units:** V

**Range:** 4V to 6V

**MFR\_READ\_VMON (F7h)**

**Definition:** Reads the VMON voltage.

**Data Length in Bytes:** 2

**Data Format:** L11

**Type:** Read only

**Default Value:** N/A

**Units:** V

**Range:** 4V to 6V

**VMON\_OV\_FAULT\_RESPONSE (F8h)**

**Definition:** Reads the VMON OV fault response.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** Read only

**Default Value:** 80h (Disable and no retry)

**Units:** N/A

**VMON\_UV\_FAULT\_RESPONSE (F9h)**

**Definition:** Reads the VMON UV fault response, which is a direct copy of VIN\_UV\_FAULT\_RESPONSE.

**Data Length in Bytes:** 1

**Data Format:** BIT

**Type:** Read only

**Default Value:** 80h (Disable and no retry)

**Units:** V

## 8. Firmware Revision History

Table 8. ISL8274M Nomenclature Guide

| Firmware Revision Code | Change Description | Note |
|------------------------|--------------------|------|
| ISL8274M-0-G0100       | Initial Release    |      |

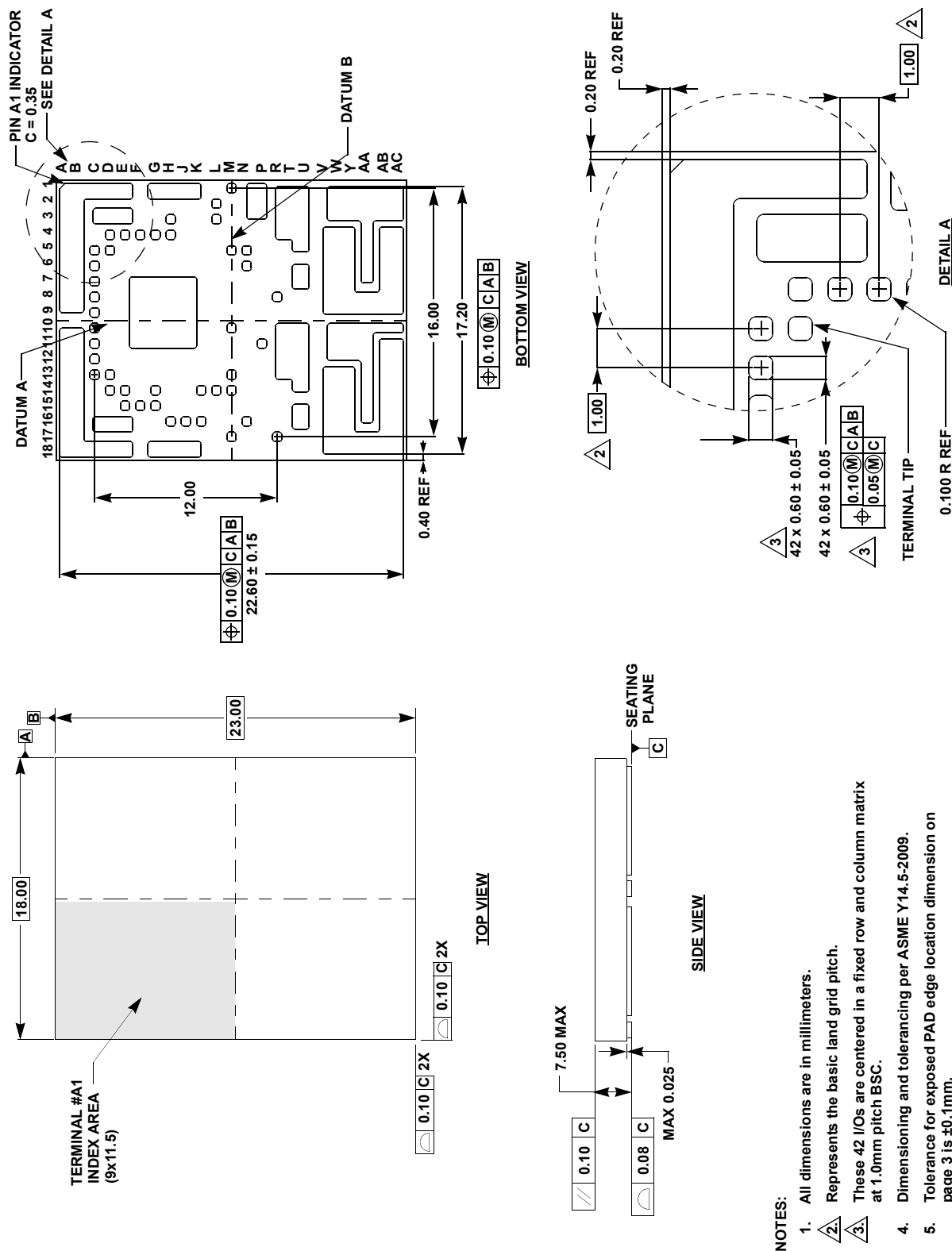


## 9. Package Outline Drawing

Y58.18x23

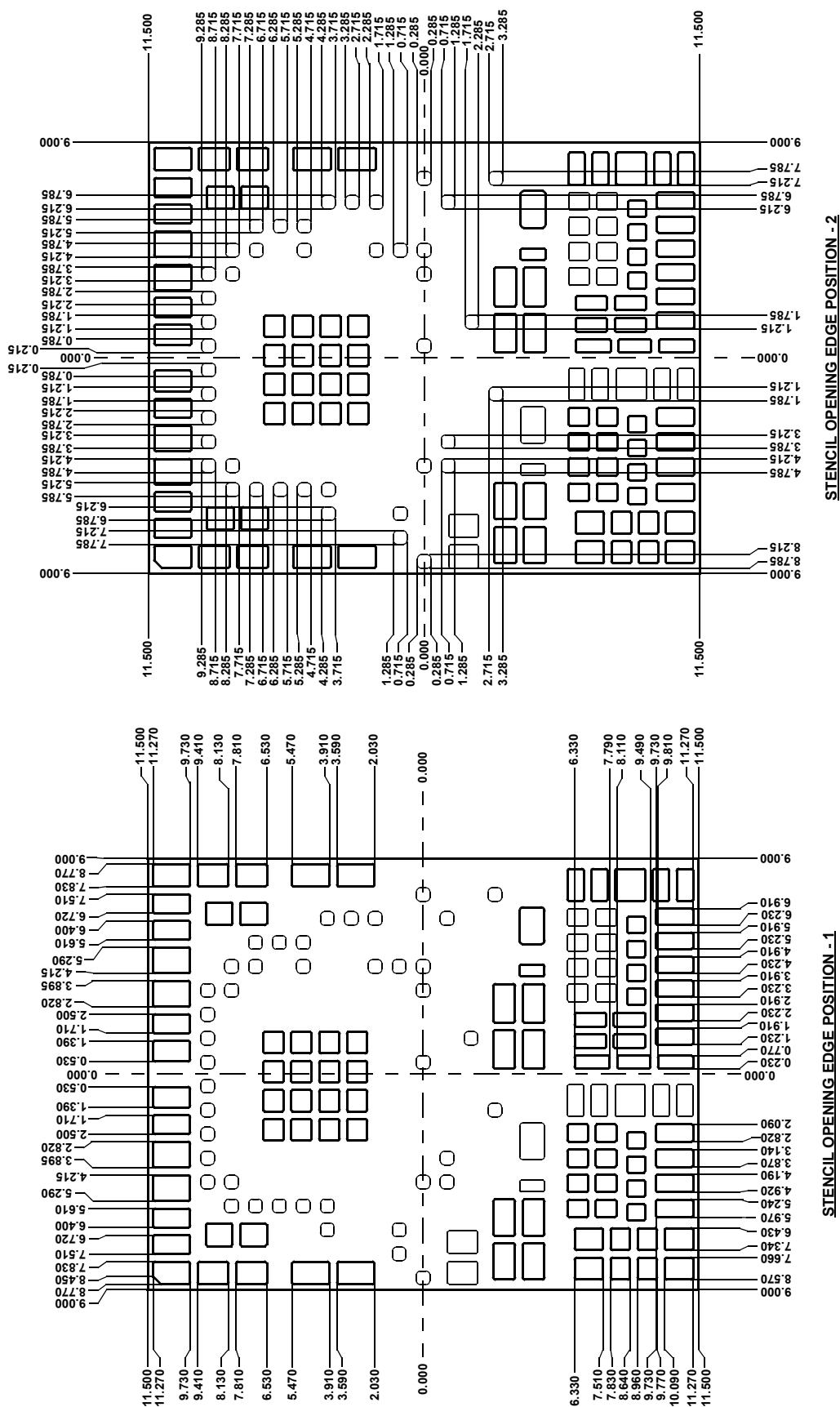
58 I/O 18mmx23mmx7.5mm CUSTOM HDA MODULE

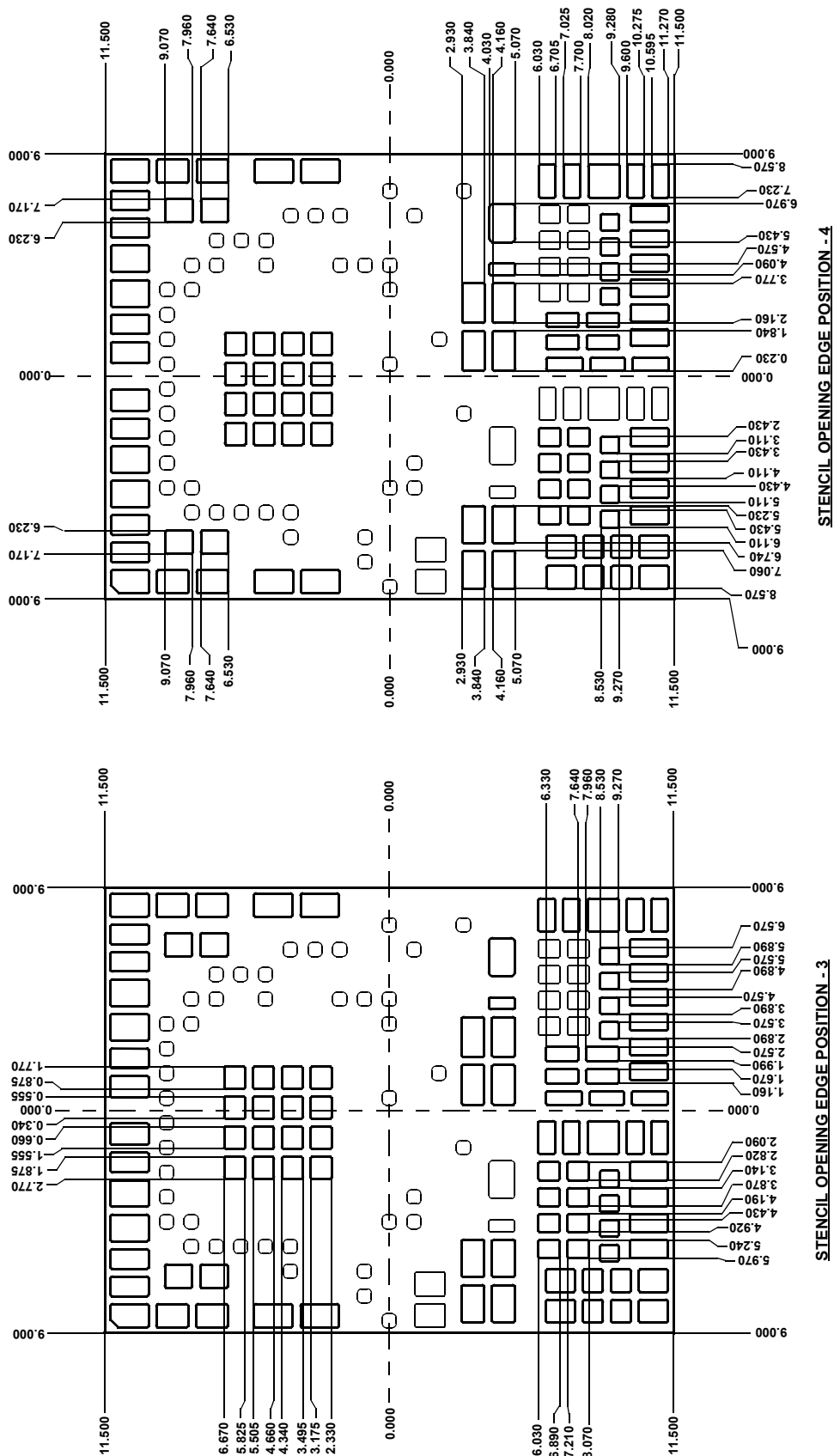
Rev 3, 12/16

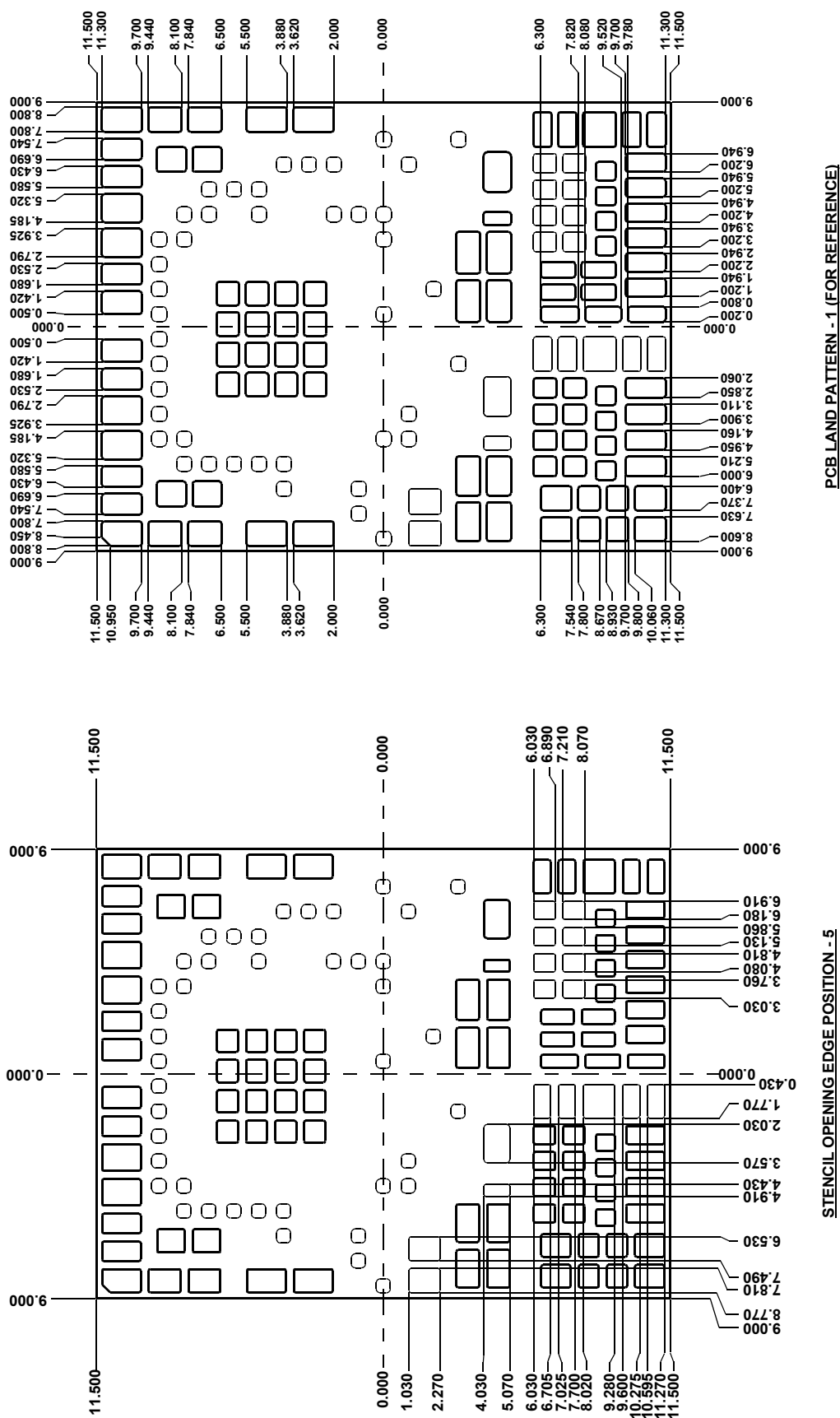
For the most recent package outline drawing, see [Y58.18x23](#).

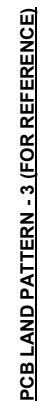


## SIZE DETAILS FOR THE 16 EXPOSED PADS











## 10. Revision History

| Rev. | Date         | Description                                                                                                                                                                                                                                                                      |
|------|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1.00 | Jan 4, 2018  | Fixed the note numbering for Table 2 on page 11.<br>Added "ISENSE_CONFIG default setting" to test conditions and updated typical from 0.1 to 0.2 for the Output Current Read Back Resolution specification on page 13.<br>Removed About Intersil section and updated disclaimer. |
| 0.00 | Nov 28, 2017 | Initial release                                                                                                                                                                                                                                                                  |



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